



Total Ionizing Dose Test Report

No. 12T-RTAX2000S-CQ352-D56J31

May 4, 2012

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I. Summary Table

| Parameter | Tolerance |
|-------------------------------------|---|
| 1. Gross Functionality | Passed 300 krad (SiO ₂) |
| 2. Power Supply Current (ICCA/ICCI) | Passed 200 krad (SiO ₂) |
| 3. Input Threshold (VTIL/VIH) | Passed 300 krad (SiO ₂) |
| 4. Output Drive (VOL/VOH) | Passed 300 krad (SiO ₂) |
| 5. Propagation Delay | Passed 300 krad (SiO ₂) for 10% degradation criterion |
| 6. Transition Characteristics | Passed 300 krad (SiO ₂) |

II. Total Ionizing Dose (TID) Testing

This testing is designed on the base of an extensive database (see TID data of antifuse-based FPGAs at <http://www.klabs.org> and <http://www.microsemi.com/soc>) accumulated from the TID testing of many generations of antifuse-based FPGAs.

A. Device-Under-Test (DUT) and Irradiation Parameters

Table 1 lists the DUT and irradiation parameters. During irradiation each input and most of the output is grounded through a 100 kΩ resistor; during annealing each input or output is tied to the ground or VCCI with a 2.7 kΩ resistor. Appendix A contains the schematics of the irradiation-bias circuit.

Table 1 DUT and Irradiation Parameters

| Part Number | RTAX2000S |
|--|--|
| Package | CQFP352 |
| Foundry | United Microelectronics Corp. |
| Technology | 0.15 μm CMOS |
| DUT Design | TOP_AX2000S_TID |
| Die Lot Number | D56J31 |
| Quantity Tested | 6 |
| Serial Number | 300 krad(SiO ₂): 3218, 3259, 3298 200 krad(SiO ₂): 3299, 3303, 3319 |
| Radiation Facility | Defense Microelectronics Activity |
| Radiation Source | Co-60 |
| Dose Rate (±5%) | 7.5 krad(SiO ₂)/min |
| Irradiation Temperature | Room |
| Irradiation and Measurement Bias (VCCI/VCCA) | Static at 3.3 V/1.5 V |

B. Test Method

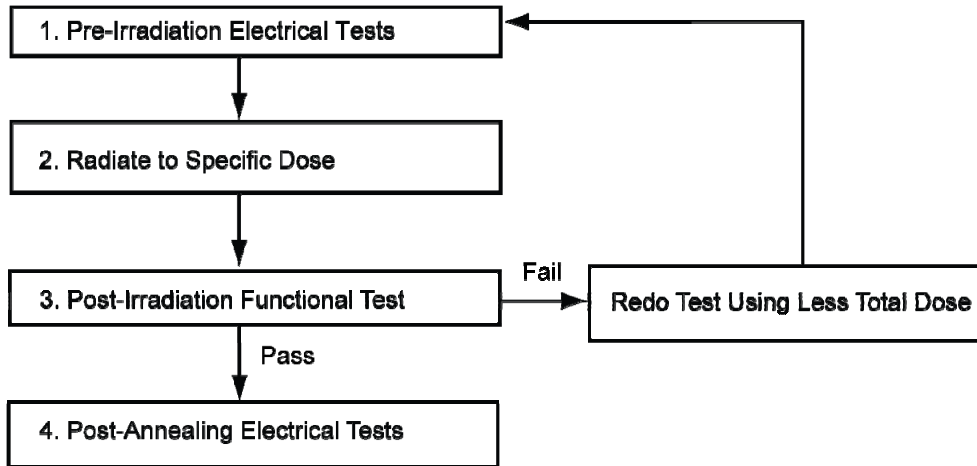


Figure 1 Parametric Test Flow Chart

The test method generally follows the guidelines in the military standard TM1019.8. Figure 1 is the flow chart describing the steps for functional and parametric tests, irradiation, and post-irradiation annealing.

The accelerated aging, or rebound test mentioned in TM1019.8 is unnecessary because there is no adverse time-dependent effect (TDE) in Microsemi products manufactured by deep sub-micron CMOS technologies. Elevated temperature annealing basically reduces the effects originating from radiation-induced leakage currents. As indicated by test data in the following sections, the predominant radiation effects in RTAX2000S are due to radiation-induced leakage currents.

Room temperature annealing is performed in this test; the duration is approximately 1 week.

C. Design and Parametric Measurements

The DUT uses a high utilization, generic design (TOP_AX2000S_TID) to evaluate total dose effects for typical space applications. Appendix B contains the schematics and Verilog files of this design.

Table 2 lists measured electrical parameters and the corresponding logic design. The functionality is measured on the output pin (O_BS) of a combinational buffer-string with 14,000 buffers, output pins (O_ANDP_CLKF, O_ORP_CLKF, O_FF_CLKF, O_ANDC_CLKF, O_ORC_CLKF, O_ANDP_CLKG, O_ORP_CLKG, O_FF_CLKG, O_ANDC_CLKG, O_ORC_CLKG, O_ANDP_CLKH, O_ORP_CLKH, O_FF_CLKH, O_ANDC_CLKH, O_ORC_CLKH, O_ANDP_HCLKA, O_ORP_HCLKA, O_FF_HCLKA, O_ANDC_HCLKA, and O_ORC_HCLKA) of four (4) shift registers with 10,728 bits total, and half of the output pins (OUTX0, OUTX1, OUTX2, OUTX3, OUTX4, OUTX5, OUTX6 and OUTX7) of the embedded RAM configured as 16K×16.

ICC is measured on the power supply of the logic-array (ICCA) and I/O (ICCI) respectively. The input logic threshold (VIL/VIH) is measured on single-ended inputs EN8, DA, IO_I1, IO_I2, IO_I3, IO_I4, IO_I5 and IO_I6, and also on differential inputs DIO_I1P, DIO_I2P, DIO_I3P, DIO_I4P, DIO_I5P, DIO_I6P and DIO_I7P. The differential inputs are configured as LVPECL instead of LVDS because LVPECL, using 3.3 VDC, is worse than LVDS, which uses 2.5 VDC. During the measurement on the differential inputs, the N (negative) side of the differential pair is biased at 1.8 V. The output-drive voltage (VOL/VOH) is measured on QA0 and YQ0. The propagation delay is measured on the output (O_BS) of the buffer string; the definition is the time delay from the triggering edge at the CLOCK input to the switching edge at the output O_BS. Both the delays of low-to-high and high-to-low output transitions are measured; the reported delay is the average of these two measurements. The transition characteristics, measured on the output O_BS, are shown as oscilloscope captures.

Table 2 Logic Design for Parametric Measurements

| Parameters | Logic Design |
|------------------------------|--|
| 1. Functionality | All key logic functions (O_BS, O_ANDP_CLKF, O_ORP_CLKF, O_FF_CLKF, O_ANDC_CLKF, O_ORC_CLKF, O_ANDP_CLKG, O_ORP_CLKG, O_FF_CLKG, O_ANDC_CLKG, O_ORC_CLKG, O_ANDP_CLKH, O_ORP_CLKH, O_FF_CLKH, O_ANDC_CLKH, O_ORC_CLKH, O_ANDP_HCLKA, O_ORP_HCLKA, O_FF_HCLKA, O_ANDC_HCLKA, and O_ORC_HCLKA), and outputs of embedded RAM (OUTX0, OUTX1, OUTX2, OUTX3, OUTX4, OUTX5, OUTX6 and OUTX7) |
| 2. ICC (ICCA/ICCI) | DUT power supply |
| 3. Input Threshold (VIL/VIH) | Single ended inputs (EN8/YQ0, DA/QA0, IO_I1/IO_O1, IO_I2/IO_O2, IO_I3/IO_O3, IO_I4/IO_O4, IO_I5/IO_O5, IO_I6/IO_O6), and differential inputs (DIO_I1P/DIO_O1, DIO_I2P/DIO_O2, DIO_I3P/DIO_O3, DIO_I4P/DIO_O4, DIO_I5P/DIO_O5, DIO_I6P/DIO_O6, DIO_I7P/DIO_O7) |
| 4. Output Drive (VOL/VOH) | Output buffer (EN8/YQ0, DA/QA0) |
| 5. Propagation Delay | String of buffers (CLOCK to O_BS) |
| 6. Transition Characteristic | String of buffers output (O_BS) |

III. Test Results

A. Functionality

Every DUT passed the pre-irradiation and post-annealing functional tests. The as-irradiated DUT is functionally tested on the output (O_FF_HCLKA) of the largest shift register.

B. Power Supply Current (ICCA and ICCI)

Figure 2 through Figure 7 plot the influx standby ICCA and ICCI versus total dose for each DUT. Table 3 summarizes the pre-irradiation, post-irradiation and post-annealing ICC. The post-annealing ICC for four different bit patterns, all '0', all '1', checkerboard and inverted-checkerboard, in the RAM are basically the same.

Table 3 Pre-irradiation, Post Irradiation and Post-Annealing ICC

| DUT | Total Dose krad(SiO ₂) | ICCA (mA) | | | ICCI (mA) | | |
|------|------------------------------------|-----------|------------|----------|-----------|------------|----------|
| | | Pre-irrad | Post-irrad | Post-ann | Pre-irrad | Post-irrad | Post-ann |
| 3218 | 300 krad | 3 | 133 | 19 | 26 | 177 | 75 |
| 3259 | 300 krad | 3 | 106 | 8 | 26 | 136 | 65 |
| 3298 | 300 krad | 3 | 106 | 9 | 26 | 133 | 62 |
| 3299 | 200 krad | 4 | 8 | 4 | 26 | 56 | 39 |
| 3303 | 200 krad | 4 | 5 | 3 | 25 | 52 | 34 |
| 3319 | 200 krad | 4 | 6 | 3 | 26 | 50 | 37 |

In compliance with TM1019.8 subsection 3.11.2.c, the post-irradiation-parametric limit (PIPL) for the post-annealing ICCI in this test is defined as the addition of highest ICCI, ICCDA and ICCDIFFA values in Table 2-4 of the *RTAX-S/SL and RTAX-DSP Radiation-Tolerant FPGAs* datasheet:

http://www.microsemi.com/soc/documents/RTAXS_DS.pdf

For ICCA, the PIPL is 500 mA; the PIPL of ICCI equals to $35 + 10 + 3.13 \times 7 = 66.91$ (mA). Note that there are 7 pairs of differential LVPECL inputs in each DUT. Based on these PIPL, post-annealed DUT passes both the ICCA and ICCI spec for 200 krad (SiO₂).

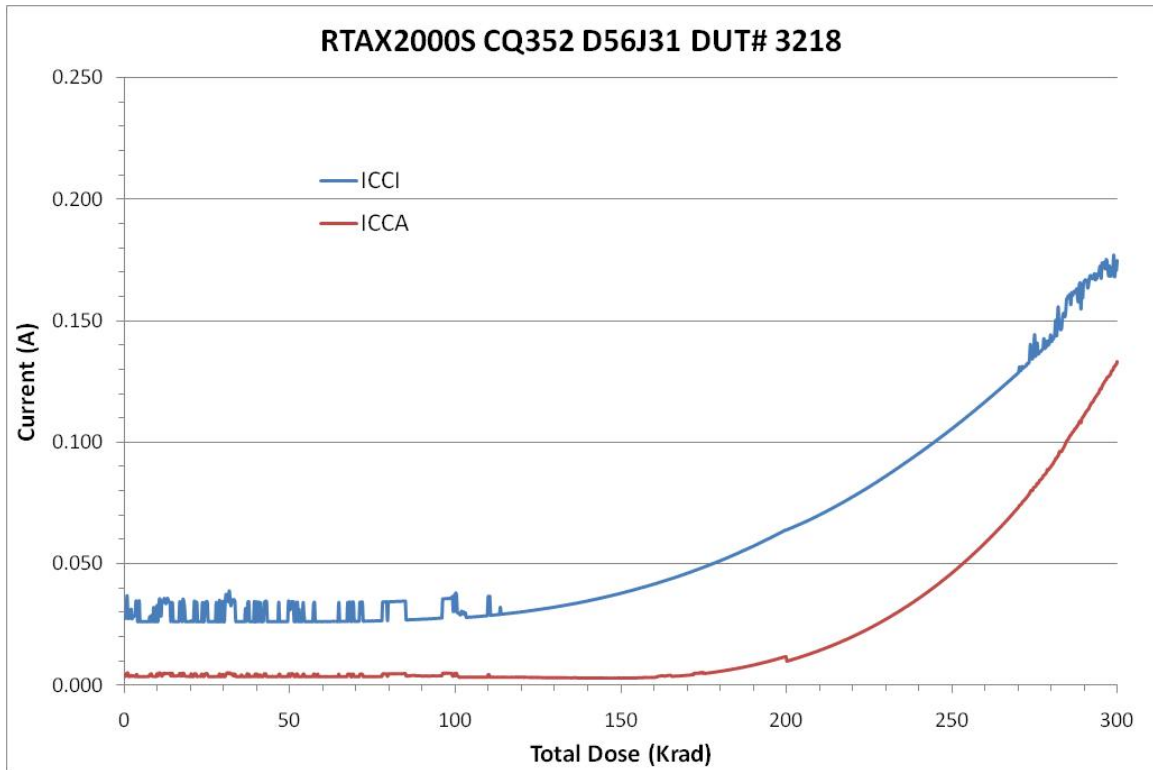


Figure 2 DUT 3218 Influx ICCA and ICCI (some measurement noises are present)

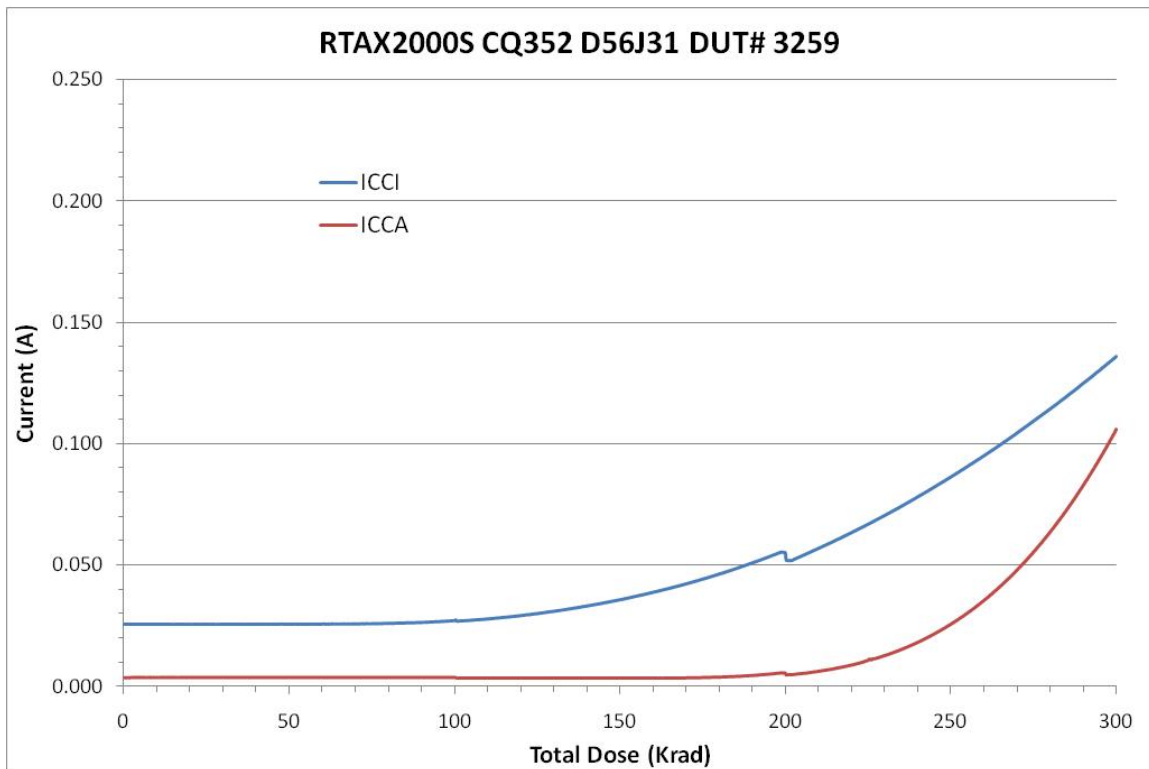


Figure 3 DUT 3259 Influx ICCA and ICCI

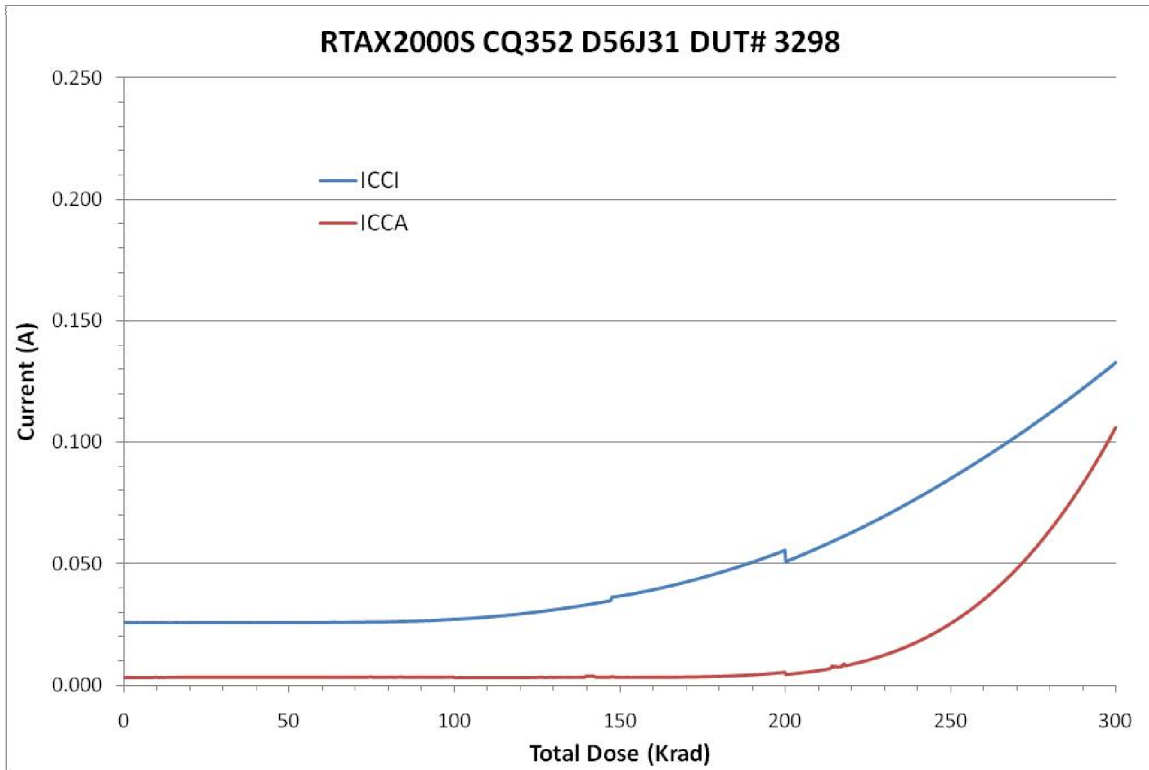


Figure 4 DUT 3298 Influx ICCA and ICCI

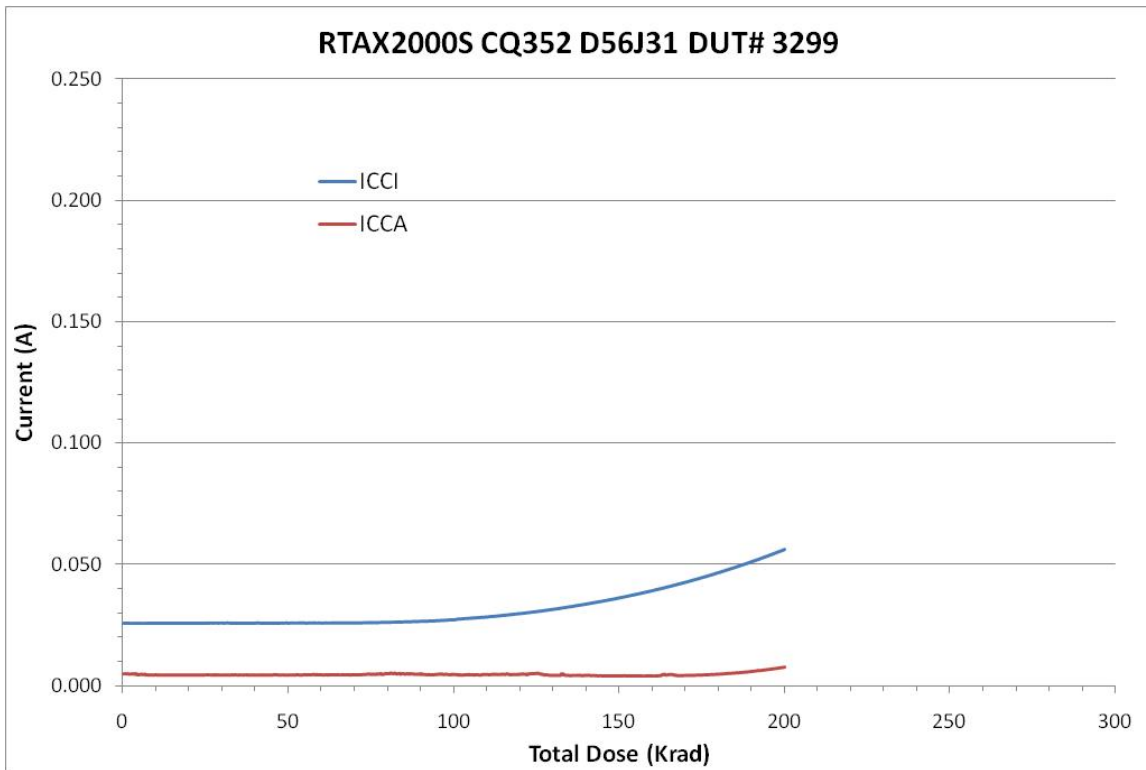


Figure 5 DUT 3299 Influx ICCA and ICCI

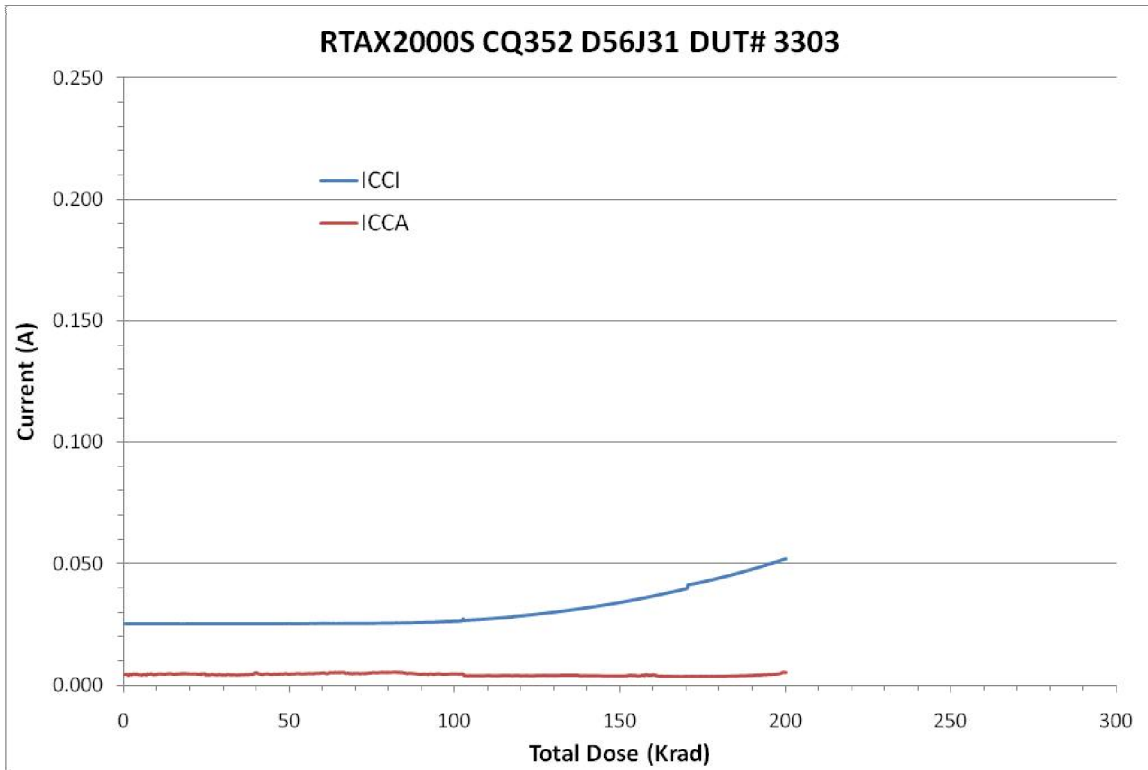


Figure 6 DUT 3303 Influx ICCA and ICCI

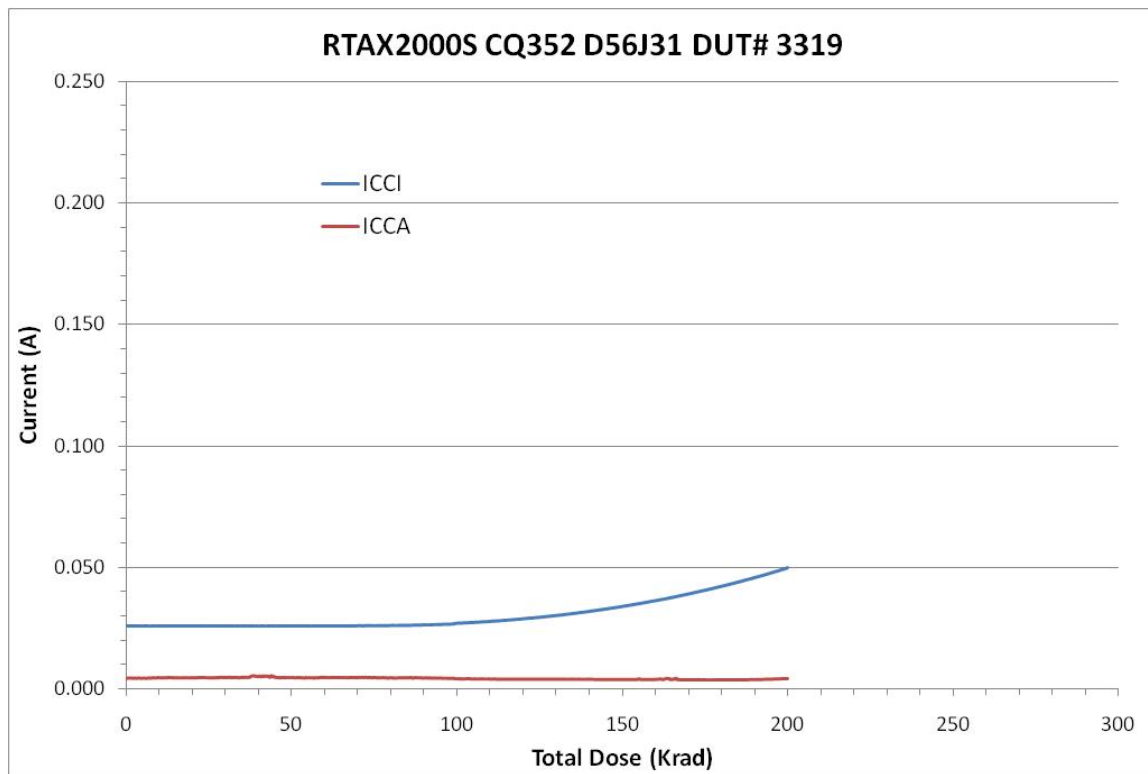


Figure 7 DUT 3319 Influx ICCA and ICCI

C. Single-Ended Input Logic Threshold (VIL/VIH)

Table 4a through Table 4c list the pre-irradiation and post-annealing single-ended input logic thresholds. All data are within the specification limits. The post-annealing shift in every case is very small.

Table 4a Pre-Irradiation and Post-Annealing Input Thresholds

| DUT | 3218 (300 krad) | | | | 3259 (300 krad) | | | |
|--------|-----------------|----------|-----------|----------|-----------------|----------|-----------|----------|
| | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann |
| | VIL (mV) | | VIH (mV) | | VIL (mV) | | VIH (mV) | |
| DA | 1405 | 1400 | 1390 | 1380 | 1410 | 1410 | 1390 | 1385 |
| EN8 | 1395 | 1385 | 1395 | 1390 | 1395 | 1385 | 1390 | 1385 |
| IO_I_6 | 1410 | 1400 | 1395 | 1390 | 1405 | 1400 | 1385 | 1385 |
| IO_I_5 | 1400 | 1390 | 1405 | 1395 | 1395 | 1390 | 1400 | 1390 |
| IO_I_4 | 1390 | 1385 | 1400 | 1390 | 1390 | 1385 | 1390 | 1390 |
| IO_I_3 | 1355 | 1345 | 1365 | 1420 | 1355 | 1340 | 1420 | 1415 |
| IO_I_2 | 1385 | 1380 | 1410 | 1400 | 1385 | 1380 | 1410 | 1400 |
| IO_I_1 | 1385 | 1380 | 1405 | 1395 | 1385 | 1380 | 1395 | 1395 |

Table 4b Pre-Irradiation and Post-Annealing Input Thresholds

| DUT | 3298 (300 krad) | | | | 3299 (200 krad) | | | |
|--------|-----------------|----------|-----------|----------|-----------------|----------|-----------|----------|
| | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann |
| | VIL (mV) | | VIH (mV) | | VIL (mV) | | VIH (mV) | |
| DA | 1415 | 1405 | 1385 | 1380 | 1415 | 1415 | 1395 | 1390 |
| EN8 | 1395 | 1390 | 1385 | 1380 | 1400 | 1390 | 1395 | 1390 |
| IO_I_6 | 1405 | 1400 | 1390 | 1385 | 1415 | 1405 | 1400 | 1385 |
| IO_I_5 | 1395 | 1390 | 1395 | 1390 | 1400 | 1395 | 1405 | 1400 |
| IO_I_4 | 1390 | 1385 | 1395 | 1385 | 1400 | 1390 | 1395 | 1395 |
| IO_I_3 | 1370 | 1335 | 1420 | 1415 | 1355 | 1345 | 1425 | 1420 |
| IO_I_2 | 1380 | 1375 | 1405 | 1395 | 1390 | 1385 | 1415 | 1405 |
| IO_I_1 | 1385 | 1375 | 1400 | 1385 | 1390 | 1385 | 1400 | 1395 |

Table 4c Pre-Irradiation and Post-Annealing Input Thresholds

| DUT | 3303 (200 krad) | | | | 3319 (200 krad) | | | |
|--------|-----------------|----------|-----------|----------|-----------------|----------|-----------|----------|
| | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann |
| | VIL (mV) | | VIH (mV) | | VIL (mV) | | VIH (mV) | |
| DA | 1415 | 1410 | 1385 | 1380 | 1415 | 1410 | 1390 | 1380 |
| EN8 | 1395 | 1390 | 1390 | 1380 | 1395 | 1395 | 1390 | 1385 |
| IO_I_6 | 1405 | 1400 | 1390 | 1385 | 1415 | 1405 | 1385 | 1385 |
| IO_I_5 | 1405 | 1395 | 1400 | 1390 | 1400 | 1395 | 1400 | 1390 |
| IO_I_4 | 1390 | 1385 | 1395 | 1385 | 1390 | 1385 | 1390 | 1390 |
| IO_I_3 | 1345 | 1335 | 1415 | 1410 | 1355 | 1340 | 1420 | 1415 |
| IO_I_2 | 1385 | 1380 | 1405 | 1400 | 1385 | 1380 | 1405 | 1400 |
| IO_I_1 | 1380 | 1380 | 1405 | 1395 | 1385 | 1380 | 1400 | 1395 |

D. Differential Input (LVPECL) Threshold Voltage (VIL/VIH)

Table 5a through Table 5c list the LVPECL differential input threshold voltage changes due to irradiations. All pins show negligible changes, and all the data are within the specification.

Table 5a Pre-Irradiation and Post-Annealing Differential Input Thresholds

| DUT | 3218 (300 krad) | | | | 3259 (300 krad) | | | |
|----------|-----------------|----------|-----------|----------|-----------------|----------|-----------|----------|
| | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann |
| | VIL (mV) | | VIH (mV) | | VIL (mV) | | VIH (mV) | |
| DIO_IP_7 | 1790 | 1790 | 1790 | 1790 | 1790 | 1790 | 1780 | 1785 |
| DIO_IP_6 | 1780 | 1780 | 1785 | 1785 | 1785 | 1785 | 1790 | 1790 |
| DIO_IP_5 | 1795 | 1795 | 1790 | 1795 | 1790 | 1790 | 1790 | 1790 |
| DIO_IP_4 | 1790 | 1790 | 1790 | 1790 | 1785 | 1780 | 1785 | 1785 |
| DIO_IP_3 | 1800 | 1800 | 1790 | 1795 | 1800 | 1800 | 1795 | 1795 |
| DIO_IP_2 | 1790 | 1790 | 1790 | 1790 | 1785 | 1785 | 1785 | 1785 |
| DIO_IP_1 | 1795 | 1790 | 1790 | 1790 | 1785 | 1785 | 1780 | 1780 |

Table 5b Pre-Irradiation and Post-Annealing Differential Input Thresholds

| DUT | 3298 (300 krad) | | | | 3299 (200 krad) | | | |
|----------|-----------------|----------|-----------|----------|-----------------|----------|-----------|----------|
| | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann |
| | VIL (mV) | | VIH (mV) | | VIL (mV) | | VIH (mV) | |
| DIO_IP_7 | 1785 | 1785 | 1785 | 1785 | 1795 | 1795 | 1790 | 1795 |
| DIO_IP_6 | 1785 | 1785 | 1790 | 1790 | 1785 | 1785 | 1790 | 1790 |
| DIO_IP_5 | 1785 | 1790 | 1785 | 1785 | 1790 | 1795 | 1790 | 1790 |
| DIO_IP_4 | 1790 | 1790 | 1790 | 1790 | 1780 | 1785 | 1790 | 1790 |
| DIO_IP_3 | 1790 | 1790 | 1785 | 1785 | 1790 | 1790 | 1785 | 1785 |
| DIO_IP_2 | 1785 | 1785 | 1785 | 1785 | 1785 | 1785 | 1785 | 1790 |
| DIO_IP_1 | 1790 | 1790 | 1785 | 1785 | 1795 | 1795 | 1790 | 1790 |

Table 5c Pre-Irradiation and Post-Annealing Differential Input Thresholds

| DUT | 3303 (200 krad) | | | | 3319 (200 krad) | | | |
|----------|-----------------|----------|-----------|----------|-----------------|----------|-----------|----------|
| | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann | Pre-Irrad | Post-Ann |
| | VIL (mV) | | VIH (mV) | | VIL (mV) | | VIH (mV) | |
| DIO_IP_7 | 1790 | 1790 | 1790 | 1790 | 1795 | 1790 | 1790 | 1790 |
| DIO_IP_6 | 1775 | 1775 | 1780 | 1780 | 1790 | 1790 | 1790 | 1795 |
| DIO_IP_5 | 1790 | 1790 | 1785 | 1790 | 1795 | 1795 | 1790 | 1790 |
| DIO_IP_4 | 1780 | 1785 | 1790 | 1790 | 1785 | 1785 | 1790 | 1790 |
| DIO_IP_3 | 1785 | 1785 | 1780 | 1780 | 1795 | 1795 | 1790 | 1790 |
| DIO_IP_2 | 1785 | 1785 | 1785 | 1785 | 1785 | 1790 | 1785 | 1785 |
| DIO_IP_1 | 1790 | 1790 | 1785 | 1790 | 1790 | 1790 | 1785 | 1785 |

E. Output-Drive Voltage (VOL/VOH)

The pre-irradiation and post-annealing VOL/VOH are listed in Tables 6 and 7. The post-annealing data are within the specification limits.

Table 6 Pre-Irradiation and Post-Annealing VOL (mV) at Various Sinking Current

| Sourcing Current | Pin\DUT | 3218 (300 krad) | | 3259 (300 krad) | | 3298 (300 krad) | | 3299 (200 krad) | | 3303 (200 krad) | | 3319 (200 krad) | |
|------------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|
| | | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an |
| 1 mA | QA0 | 9 | 8 | 9 | 8 | 8 | 8 | 9 | 8 | 9 | 8 | 9 | 9 |
| | YQ0 | 10 | 10 | 10 | 9 | 10 | 9 | 10 | 9 | 10 | 9 | 10 | 10 |
| 12 mA | QA0 | 99 | 96 | 99 | 96 | 97 | 94 | 97 | 94 | 98 | 94 | 100 | 97 |
| | YQ0 | 113 | 109 | 108 | 103 | 108 | 102 | 108 | 103 | 108 | 103 | 113 | 109 |
| 20 mA | QA0 | 166 | 160 | 166 | 160 | 162 | 156 | 162 | 157 | 163 | 157 | 167 | 162 |
| | YQ0 | 190 | 181 | 180 | 172 | 179 | 171 | 180 | 172 | 179 | 172 | 189 | 182 |
| 50 mA | QA0 | 421 | 406 | 420 | 406 | 412 | 398 | 412 | 399 | 412 | 400 | 423 | 411 |
| | YQ0 | 480 | 460 | 456 | 437 | 454 | 433 | 457 | 437 | 453 | 435 | 478 | 460 |
| 100 mA | QA0 | 891 | 859 | 887 | 858 | 871 | 841 | 875 | 845 | 872 | 845 | 895 | 868 |
| | YQ0 | 1010 | 967 | 959 | 919 | 953 | 910 | 963 | 922 | 954 | 916 | 1004 | 966 |

Table 7 Pre-Irradiation and Post-Annealing VOH (mV) at Various Sourcing Current

| Sourcing Current | Pin\DUT | 3218 (300 krad) | | 3259 (300 krad) | | 3298 (300 krad) | | 3299 (200 krad) | | 3303 (200 krad) | | 3319 (200 krad) | |
|------------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|---------|
| | | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an | Pre-rad | Post-an |
| 1 mA | QA0 | 3288 | 3287 | 3288 | 3287 | 3288 | 3287 | 3288 | 3288 | 3288 | 3289 | 3288 | 3289 |
| | YQ0 | 3286 | 3282 | 3287 | 3284 | 3287 | 3284 | 3293 | 3285 | 3287 | 3286 | 3286 | 3285 |
| 8 mA | QA0 | 3215 | 3214 | 3216 | 3215 | 3217 | 3216 | 3217 | 3218 | 3217 | 3218 | 3215 | 3216 |
| | YQ0 | 3207 | 3203 | 3211 | 3208 | 3212 | 3209 | 3211 | 3210 | 3211 | 3211 | 3207 | 3207 |
| 20 mA | QA0 | 3090 | 3088 | 3091 | 3089 | 3093 | 3093 | 3094 | 3095 | 3093 | 3094 | 3089 | 3089 |
| | YQ0 | 3068 | 3066 | 3079 | 3077 | 3079 | 3078 | 3079 | 3079 | 3080 | 3080 | 3070 | 3070 |
| 50 mA | QA0 | 2759 | 2756 | 2764 | 2760 | 2770 | 2767 | 2771 | 2771 | 2768 | 2768 | 2758 | 2758 |
| | YQ0 | 2707 | 2706 | 2735 | 2734 | 2736 | 2735 | 2732 | 2736 | 2735 | 2738 | 2711 | 2713 |
| 100 mA | QA0 | 2117 | 2107 | 2134 | 2123 | 2144 | 2136 | 2147 | 2144 | 2138 | 2134 | 2120 | 2114 |
| | YQ0 | 2017 | 2013 | 2080 | 2077 | 2080 | 2079 | 2073 | 2078 | 2080 | 2082 | 2033 | 2033 |

F. Propagation Delay

The propagation delay was measured in-situ, post-irradiation, and post-annealing. The irradiation was temporarily stopped at each total-dose increment of 100 krad for the measurement. Each measurement has a 2-minute wait after a DUT is removed from the chamber. The results are plotted in Figure 8, and listed in Table 8. As shown in Figure 8, the propagation delay initially decreases with the total dose, but the change is small throughout the irradiation. Referring to influx static current plots (Figure 2 through Figure 7), a device probably heats up as the dose increases. The rising temperature could be the root cause of the increasing trend at high doses. The post-annealing data, on the other hand, show decreased delay in every case.

The radiation delta in every case is well within the 10% degradation criterion. User can take the worst case for the design-margin consideration.

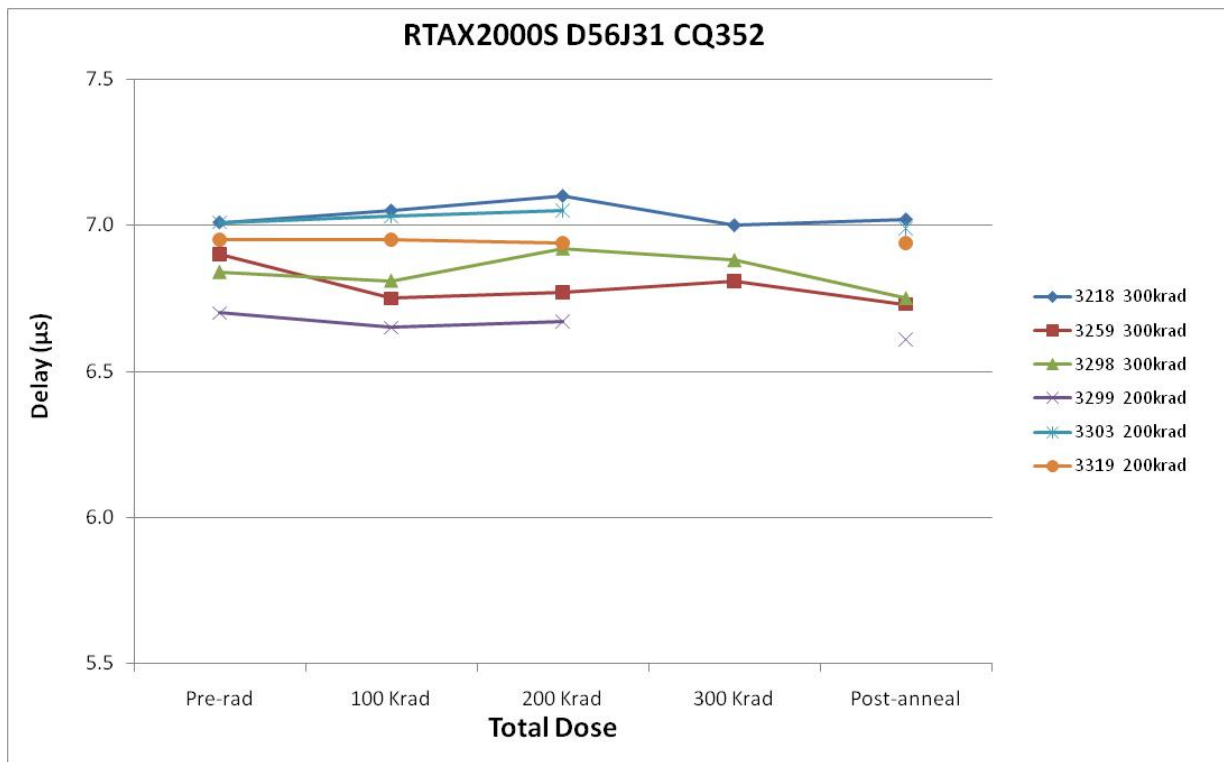


Figure 8 In-Situ Propagation Delay versus Total Dose.
The measurement is performed outside the irradiation chamber.

Table 8 Radiation-Induced Propagation-Delay Degradations

| RTAX2000S D56J31 CQ352 | | | | | | | |
|-------------------------------|------------|-------------------|----------------|-----------------|-----------------|-----------------|-----------------|
| Delay (μs) | | | | | | | |
| | DUT | Total Dose | Pre-rad | 100 krad | 200 krad | 300 krad | Post-ann |
| | 3218 | 300 krad | 7.01 | 7.05 | 7.10 | 7.00 | 7.02 |
| | 3259 | 300 krad | 6.90 | 6.75 | 6.77 | 6.81 | 6.73 |
| | 3298 | 300 krad | 6.84 | 6.81 | 6.92 | 6.88 | 6.75 |
| | 3299 | 200 krad | 6.70 | 6.65 | 6.67 | - | 6.61 |
| | 3303 | 200 krad | 7.01 | 7.03 | 7.05 | - | 6.99 |
| | 3319 | 200 krad | 6.95 | 6.95 | 6.94 | - | 6.94 |
| Radiation Δ (%) | | | | | | | |
| | DUT | Total Dose | Pre-rad | 100 krad | 200 krad | 300 krad | Post-ann |
| | 3218 | 300 krad | - | 0.57% | 1.28% | -0.14% | 0.14% |
| | 3259 | 300 krad | - | -2.17% | -1.88% | -1.30% | -2.46% |
| | 3298 | 300 krad | - | -0.44% | 1.17% | 0.58% | -1.32% |
| | 3299 | 200 krad | - | -0.75% | -0.45% | - | -1.34% |
| | 3303 | 200 krad | - | 0.29% | 0.57% | - | -0.29% |
| | 3319 | 200 krad | - | 0.00% | -0.14% | - | -0.14% |

G. Transition Characteristics

Figure 9a to Figure 20b show the pre-irradiation and post-annealing transition edges. In each case, the radiation-induced transition-time degradation is insignificant.

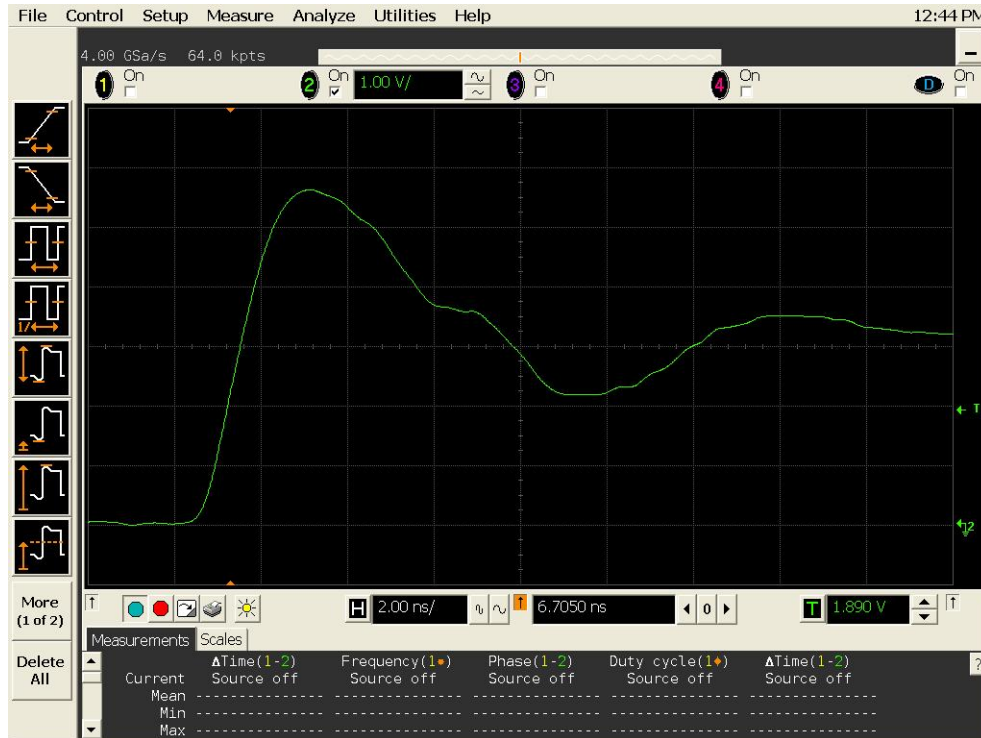


Figure 9a DUT 3218 Pre-Irradiation Rising Edge

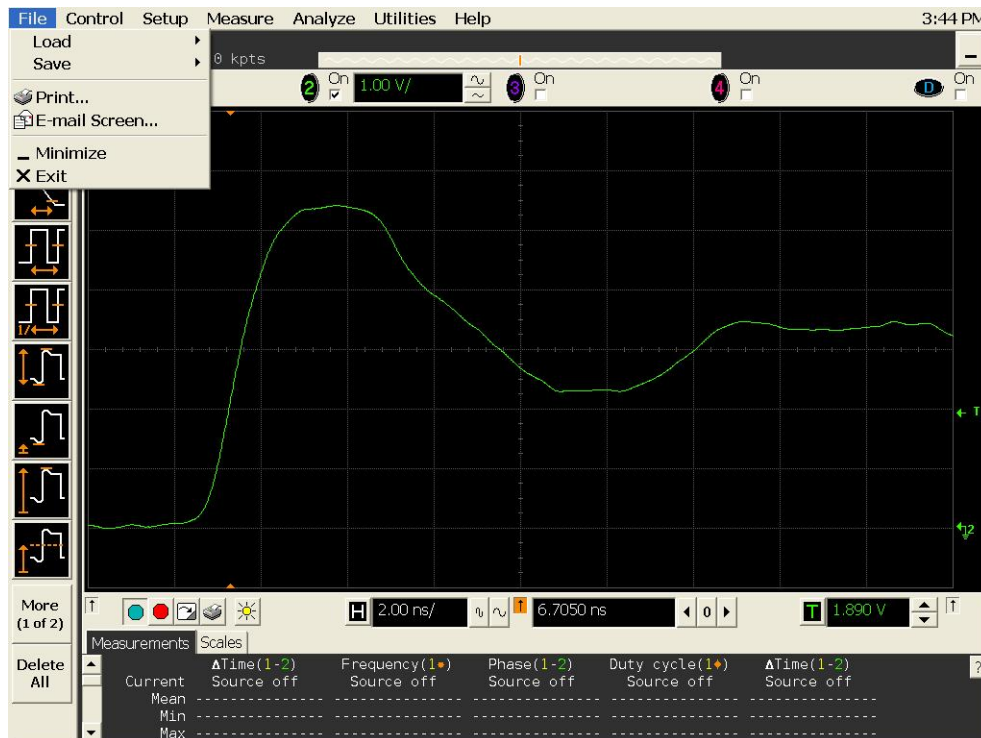


Figure 9b DUT 3218 Post-Annealing Rising Edge

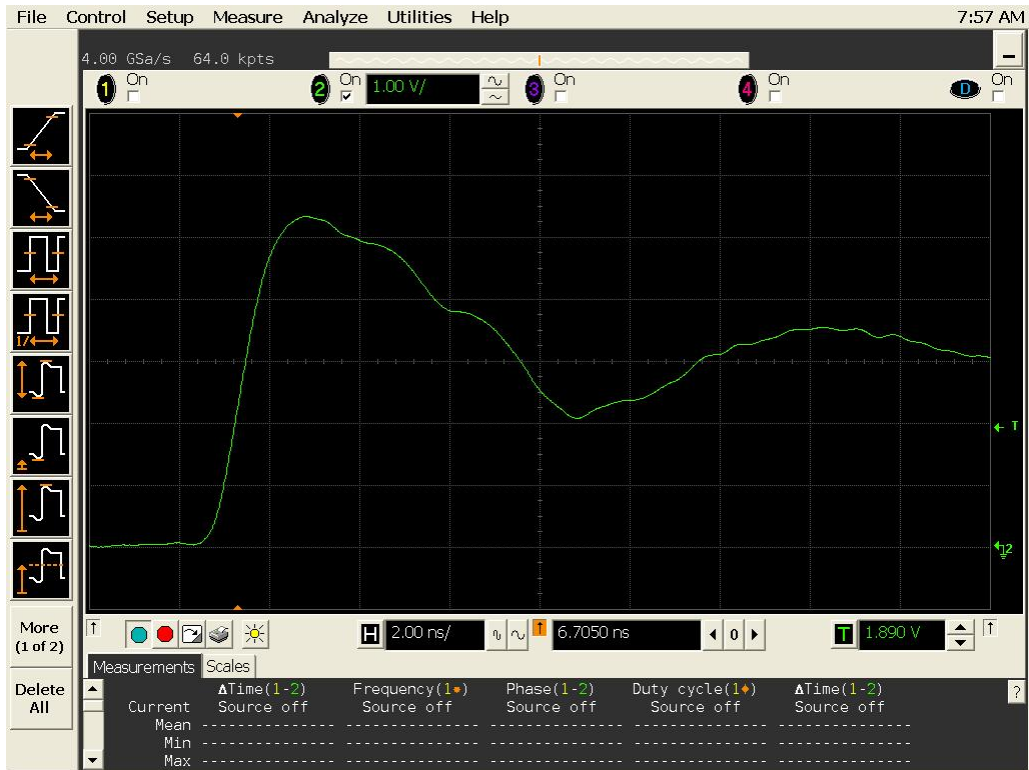


Figure 10a DUT 3259 Pre-Irradiation Rising Edge

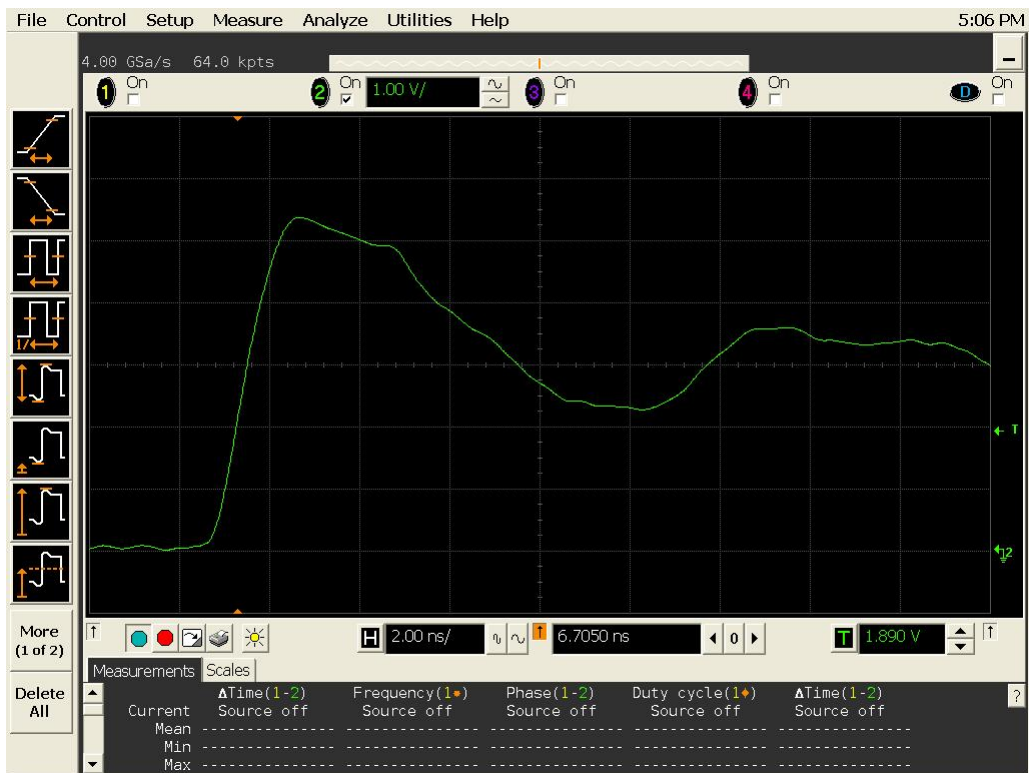


Figure 10b DUT 3259 Post-Annealing Rising Edge

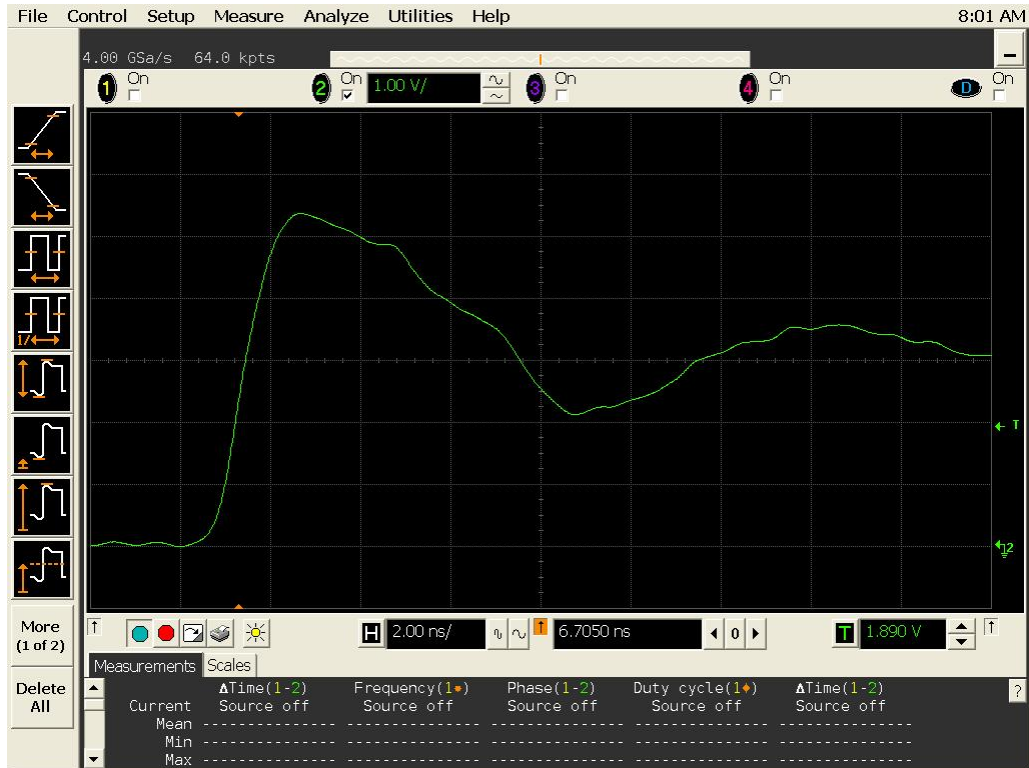


Figure 11a DUT 3298 Pre-Radiation Rising Edge

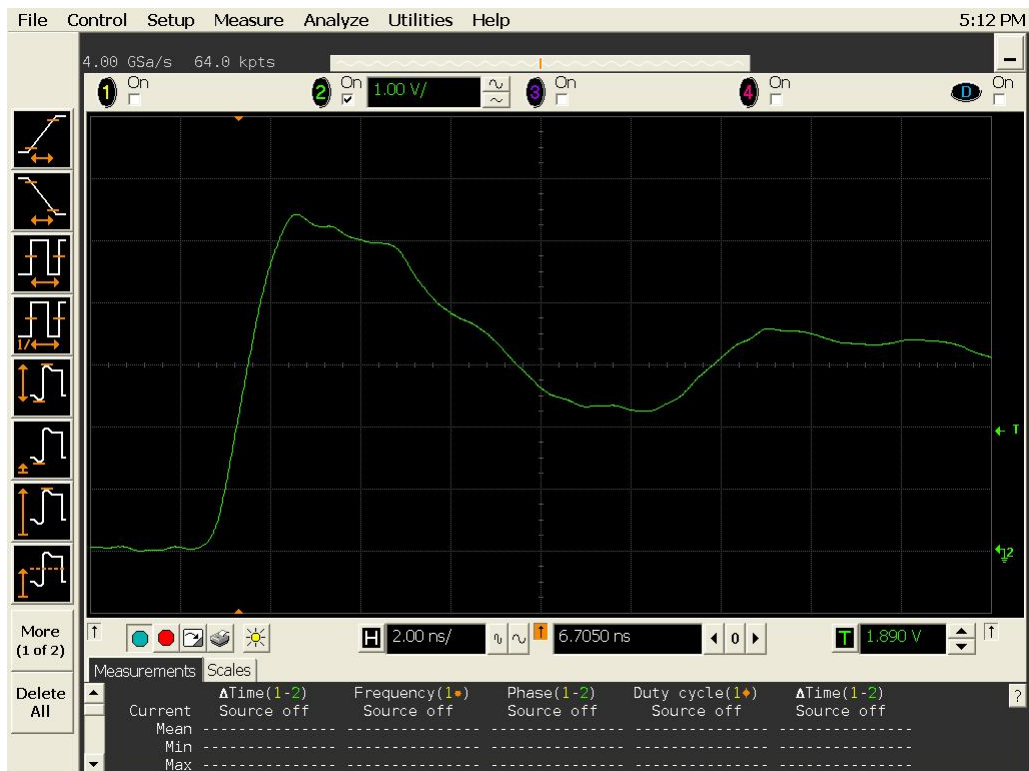


Figure 11b DUT 3298 Post-Annealing Rising edge

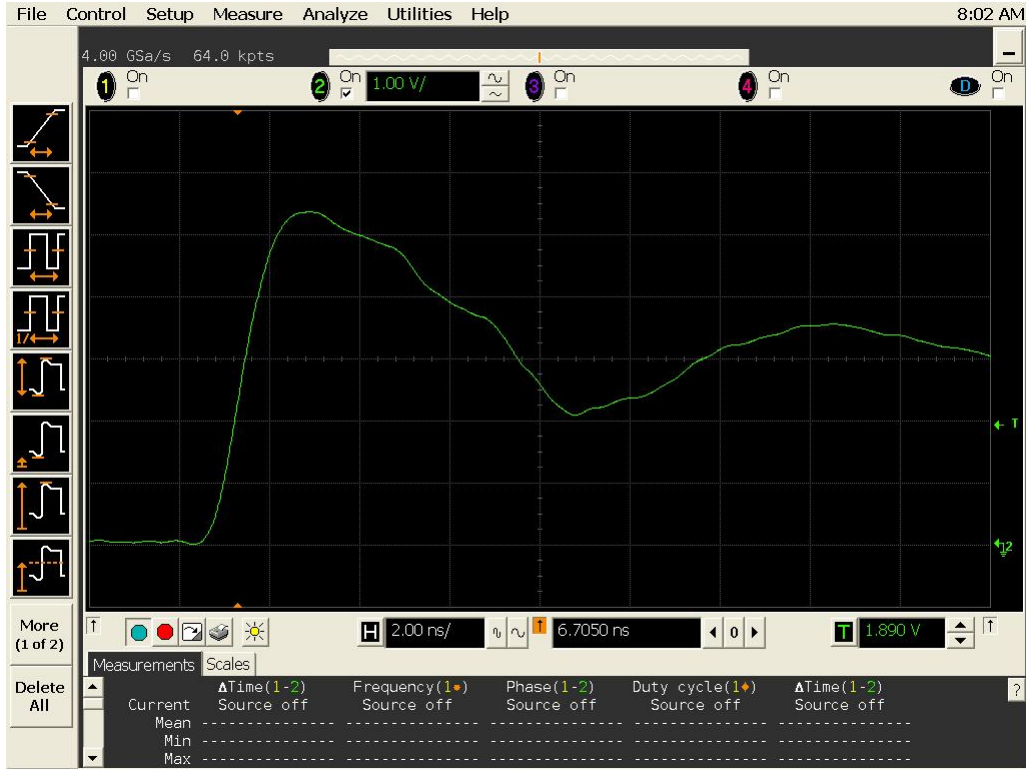


Figure 12a DUT 3299 Pre-Irradiation Rising Edge

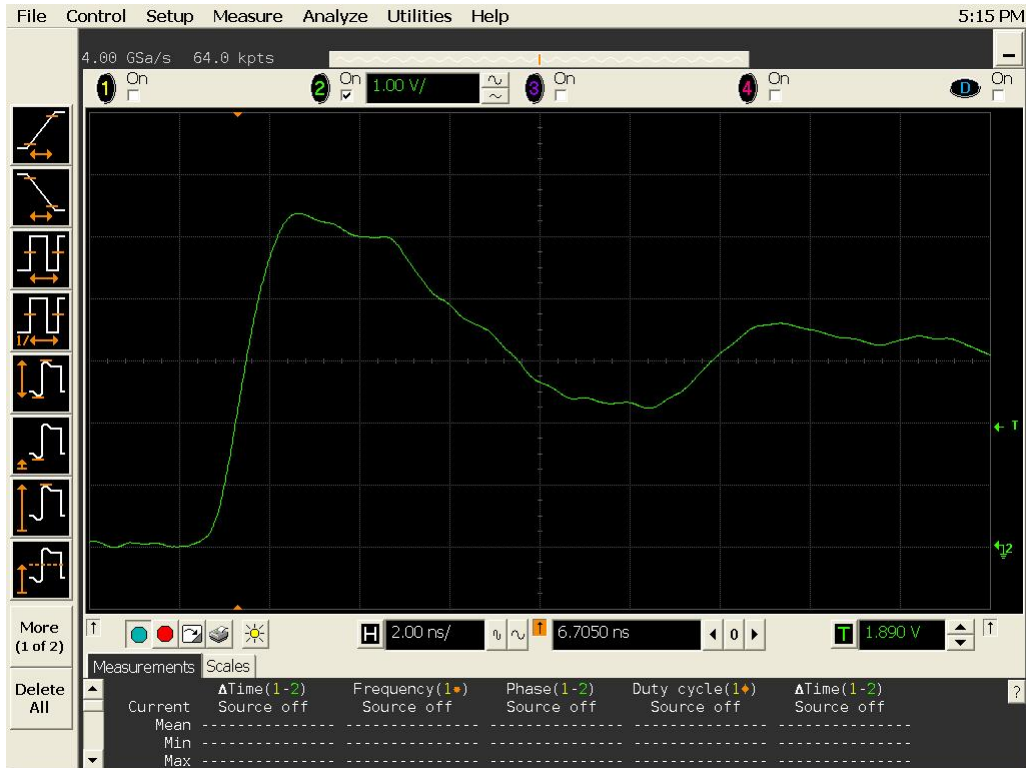


Figure 12b DUT 3299 Post-Annealing Rising Edge

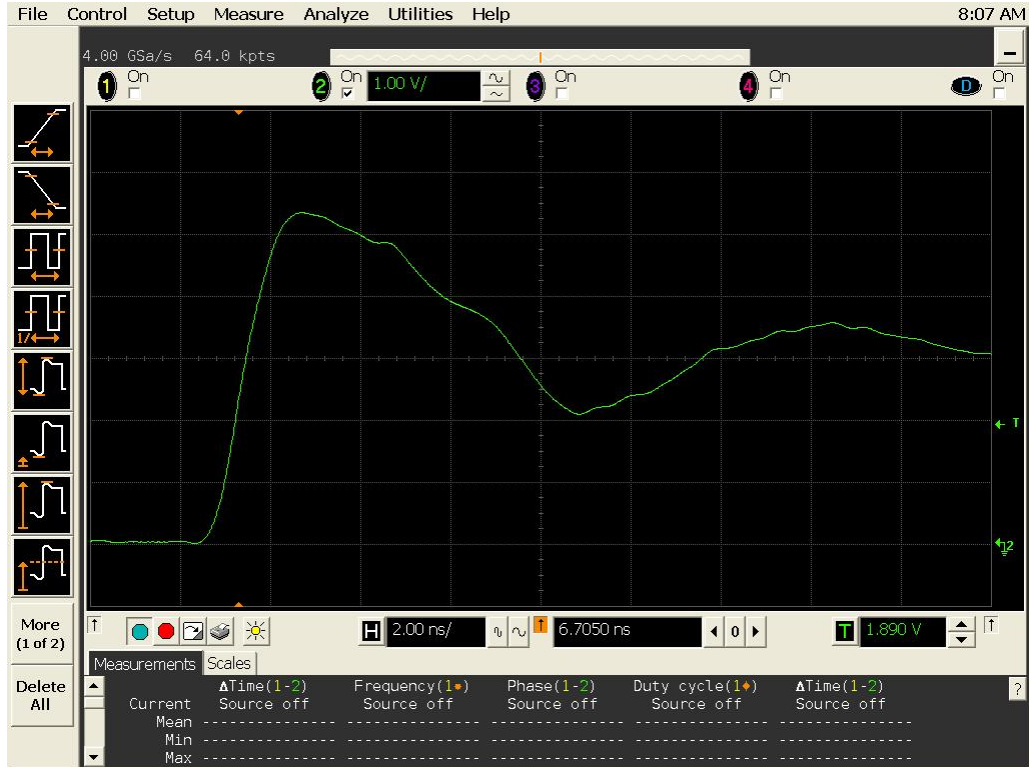


Figure 13a DUT 3303 Pre-Irradiation Rising Edge

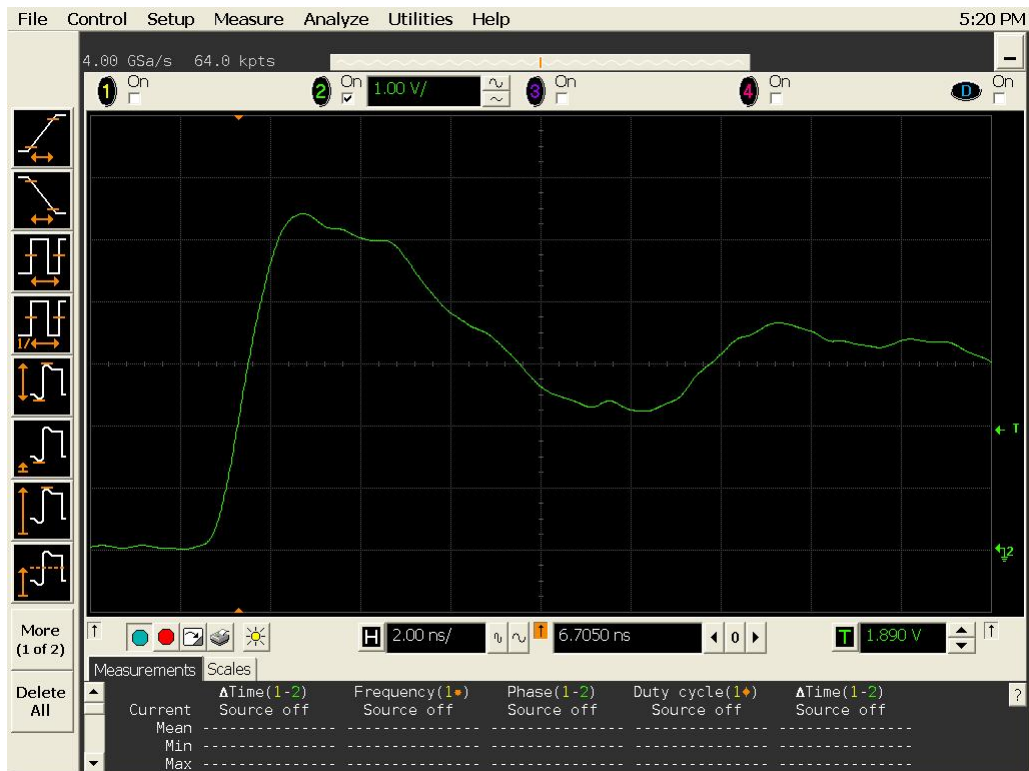


Figure 13b DUT 3303 Post-Annealing Rising Edge

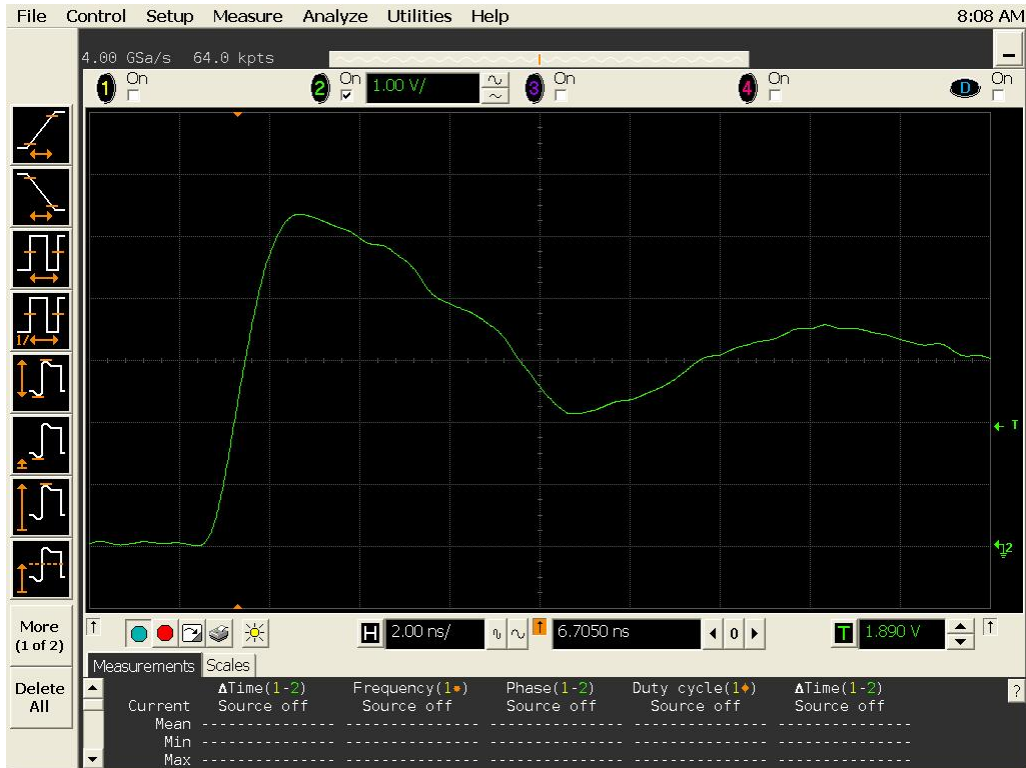


Figure 14a DUT 3319 Pre-Irradiation Rising Edge

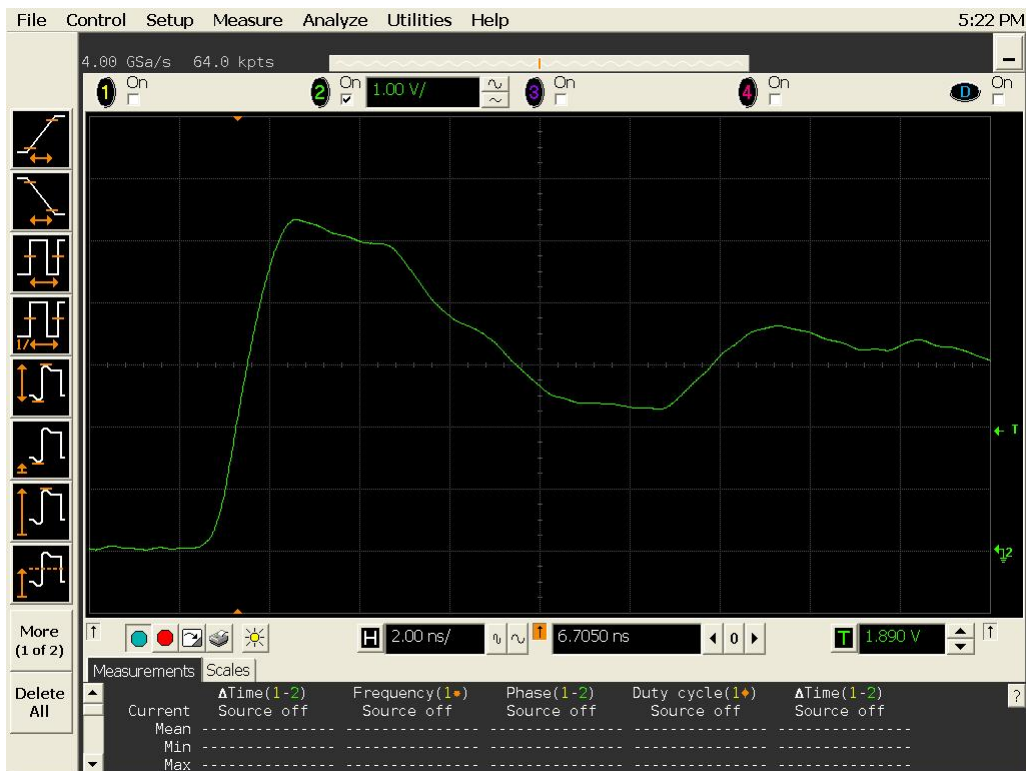


Figure 14b DUT 3319 Post-Annealing Rising Edge

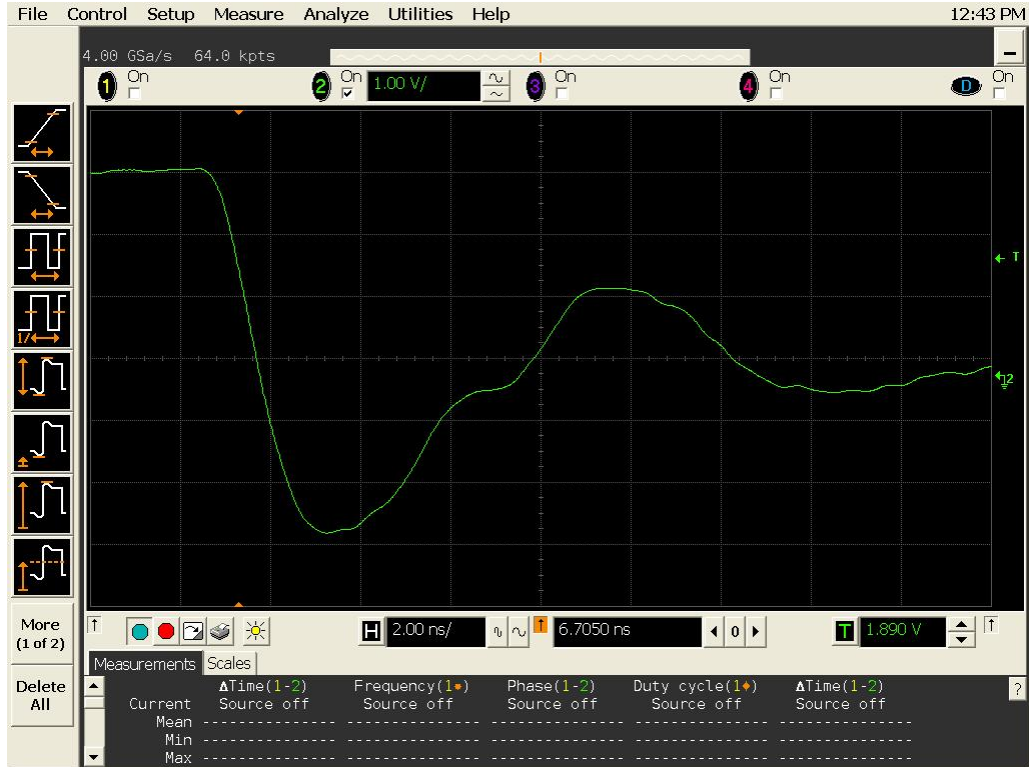


Figure 15a DUT 3218 Pre-Radiation Falling Edge

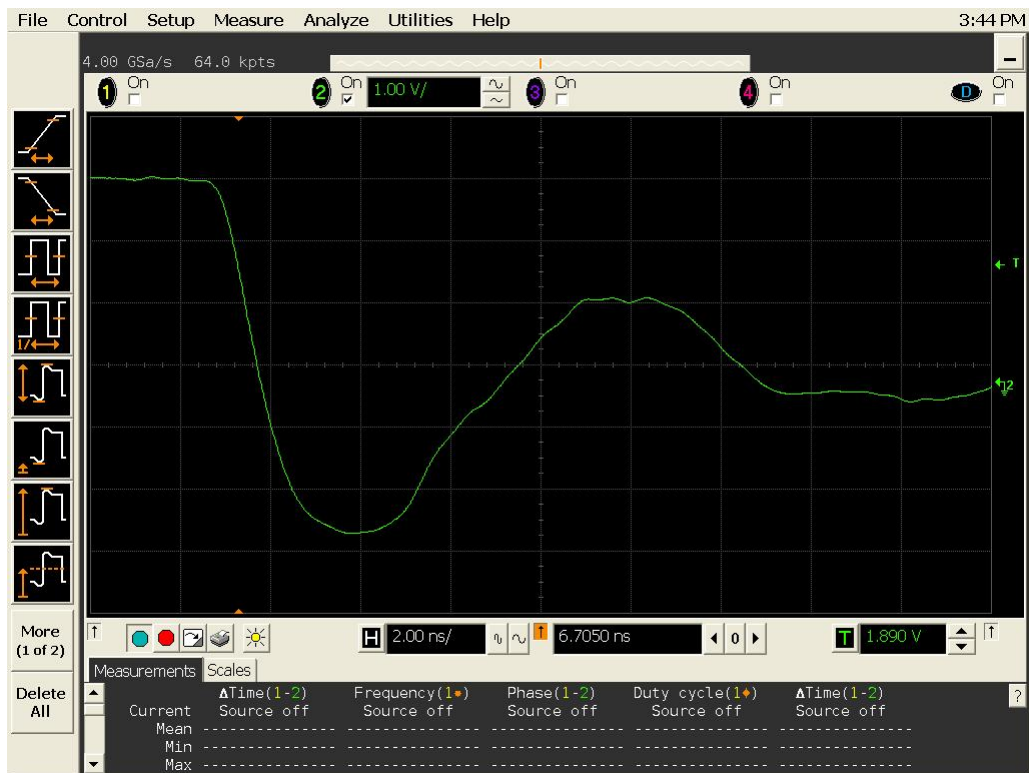


Figure 15b DUT 3218 Post-Annealing Falling Edge

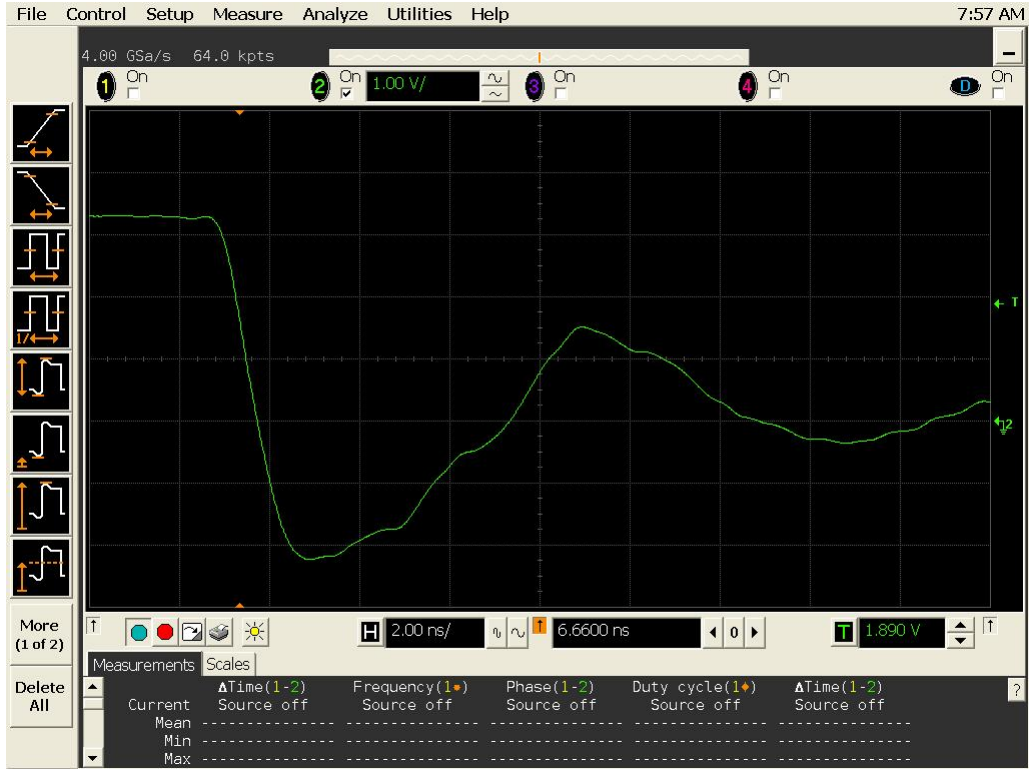


Figure 16a DUT 3259 Pre-Irradiation Falling Edge

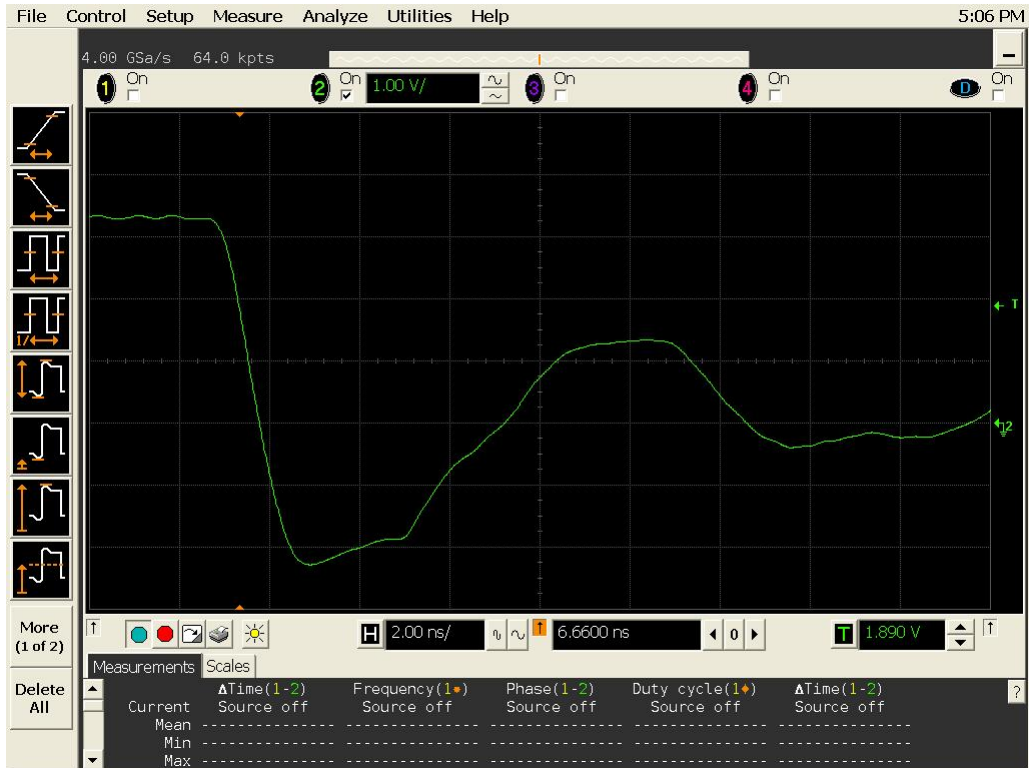


Figure 16b DUT 3259 Post-Annealing Falling Edge

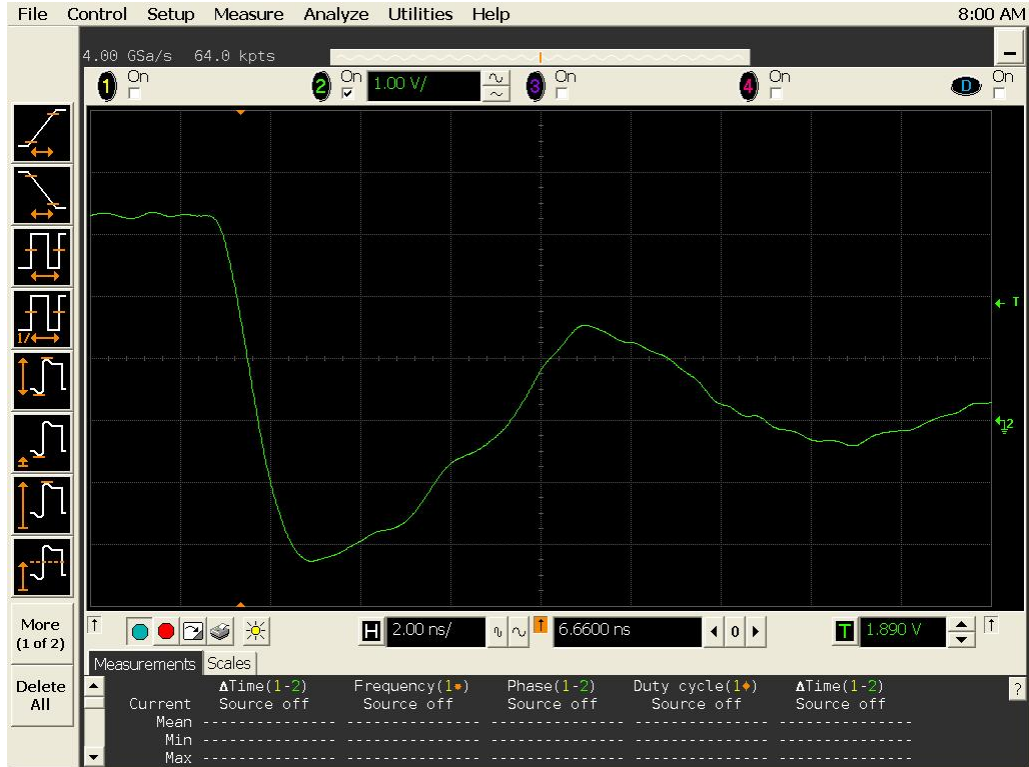


Figure 17a DUT 3298 Pre-Irradiation Falling Edge

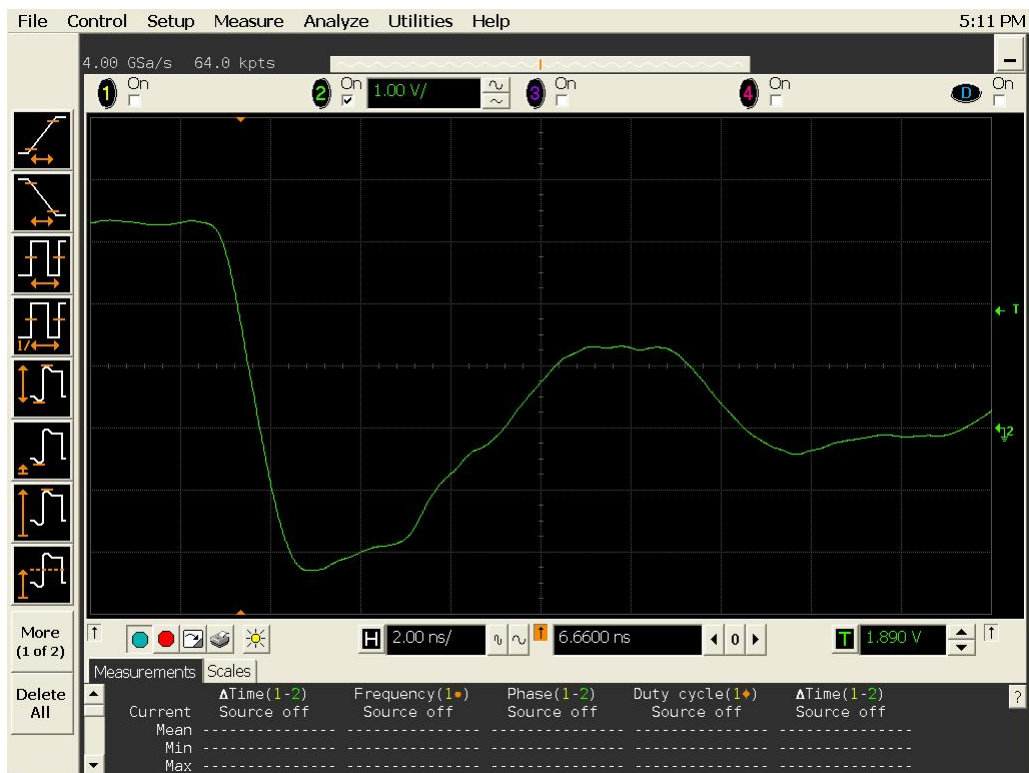


Figure 17b DUT 3298 Post-Annealing Falling Edge

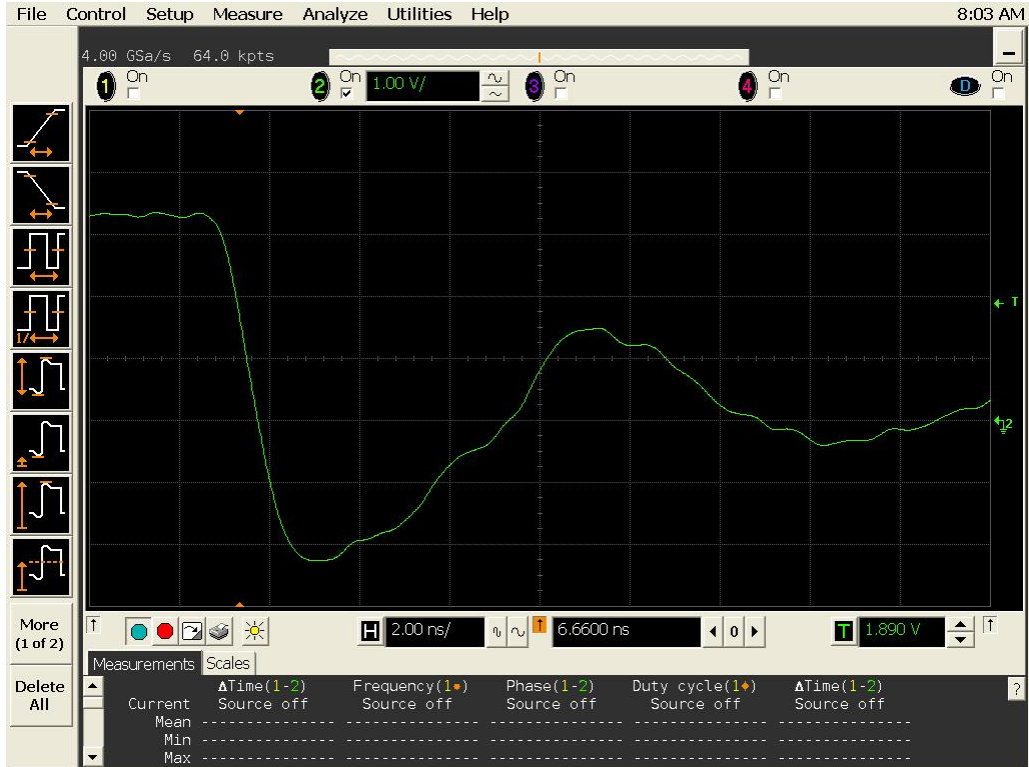


Figure 18a DUT 3299 Pre-Irradiation Falling Edge

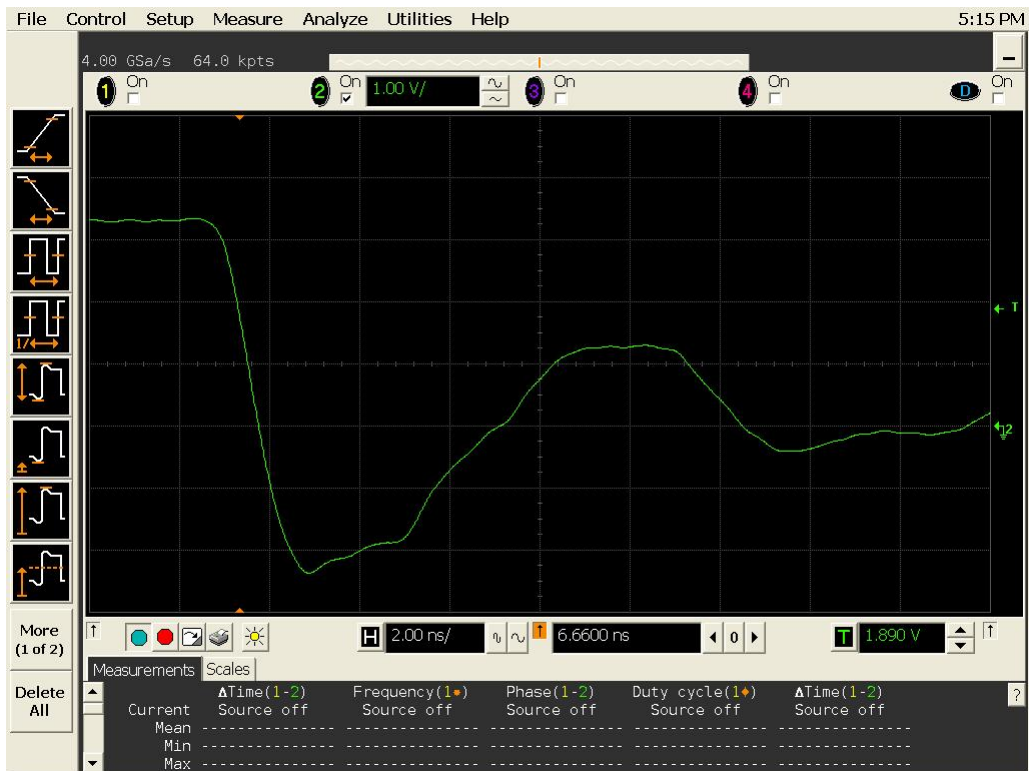


Figure 18b DUT 3299 Post-Annealing Falling Edge

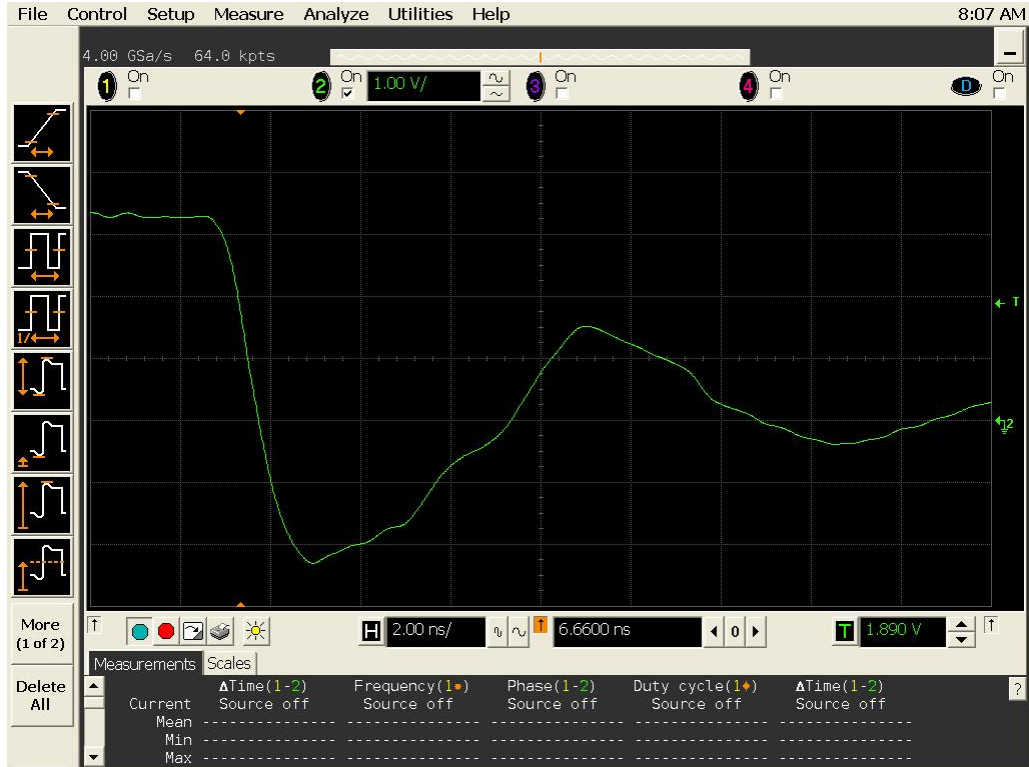


Figure 19a DUT 3303 Pre-Irradiation Falling Edge

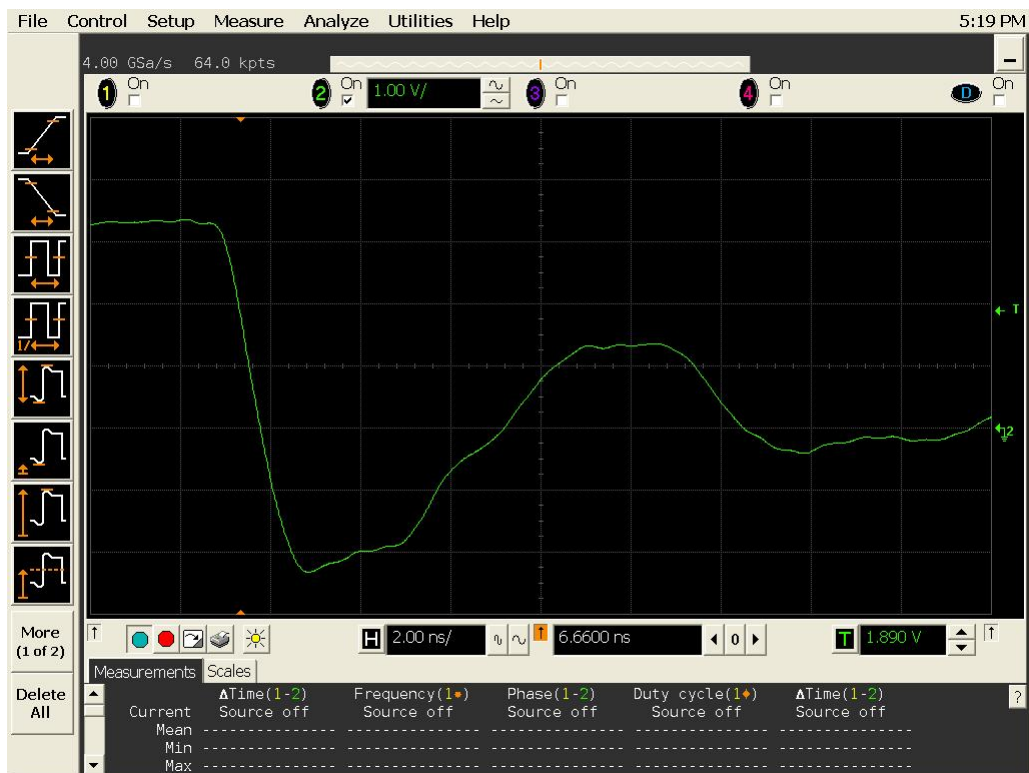


Figure 19b DUT 3303 Post-Annealing Falling Edge

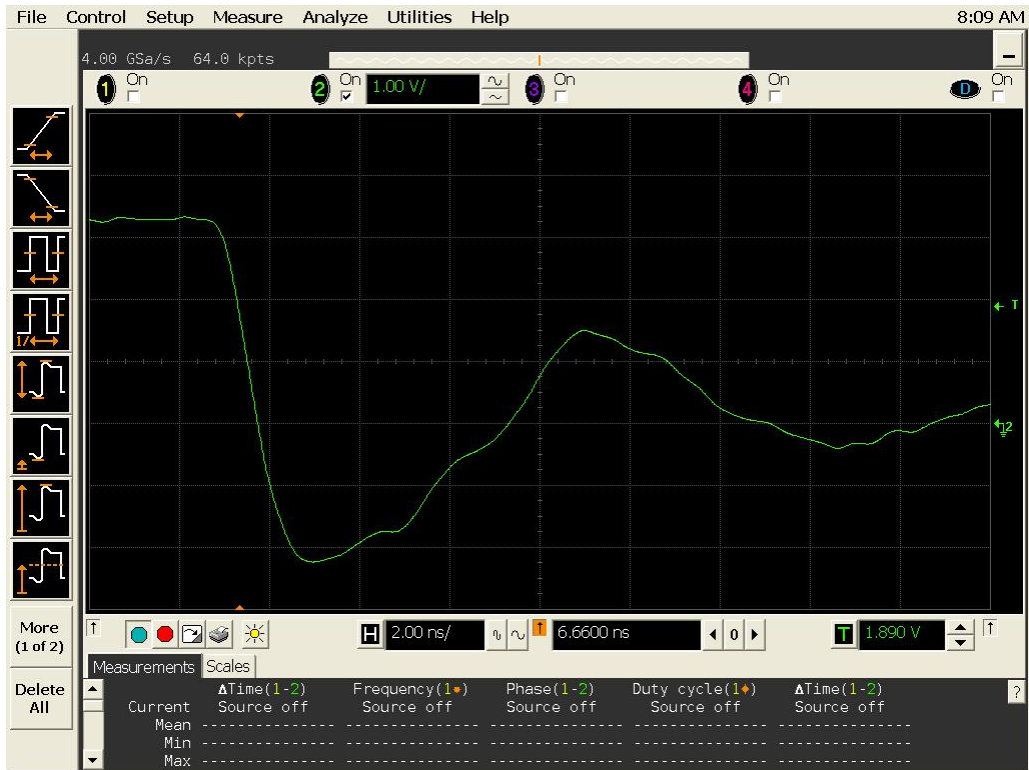


Figure 20a DUT 3319 Pre-Irradiation Falling Edge

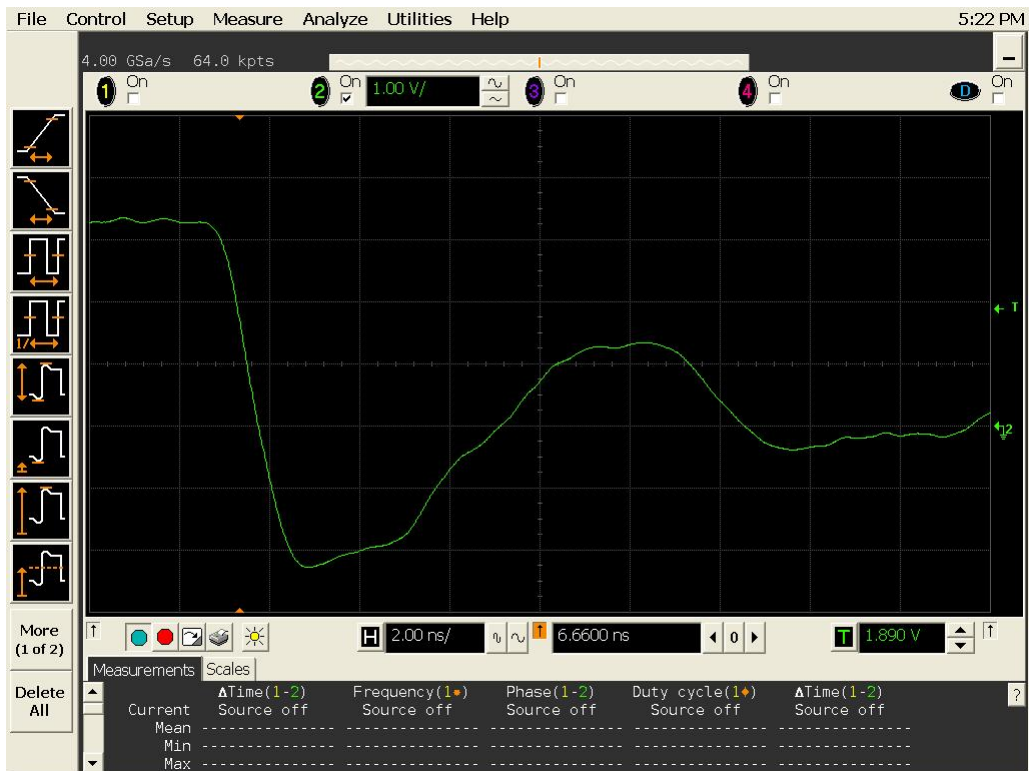


Figure 20b DUT 3319 Post-Annealing Falling Edge

Appendix A DUT Bias



Figure A1 I/O Bias During Irradiation

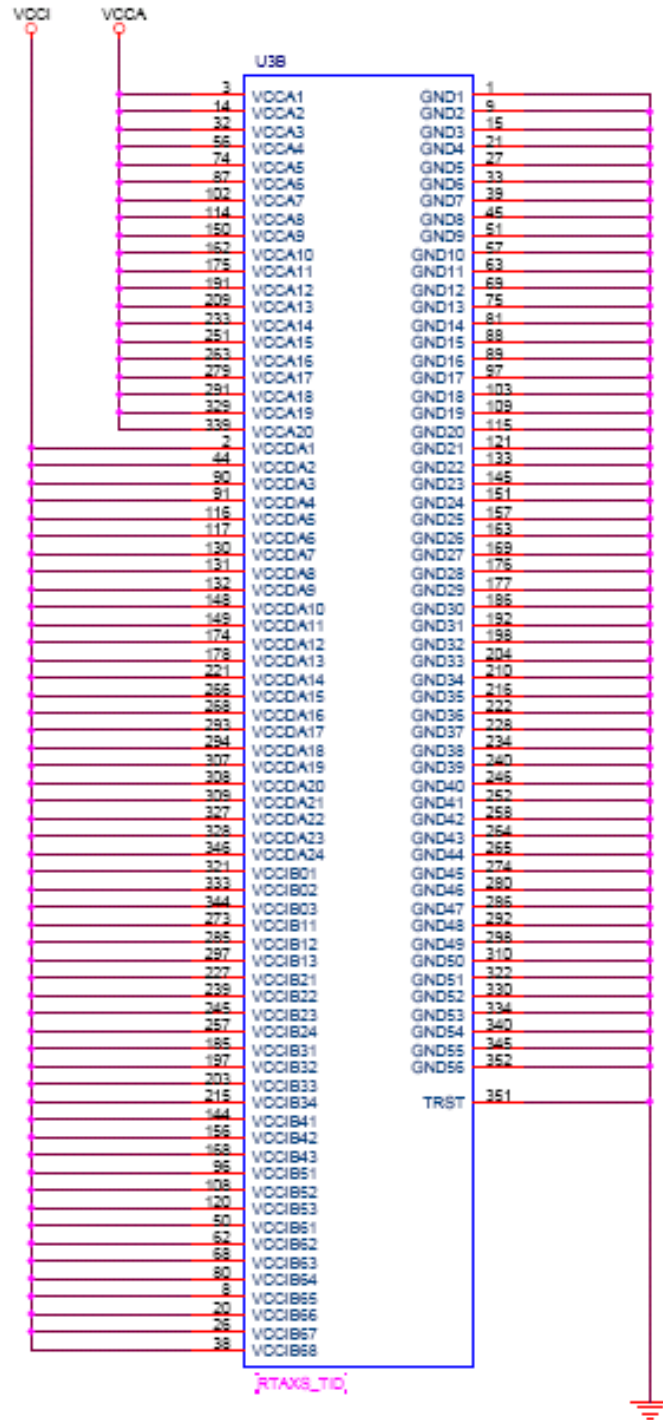
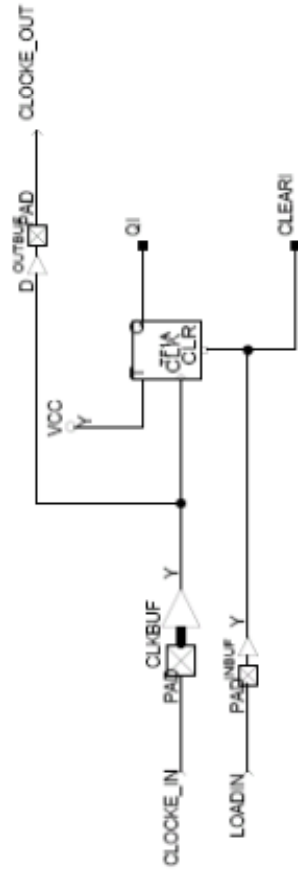
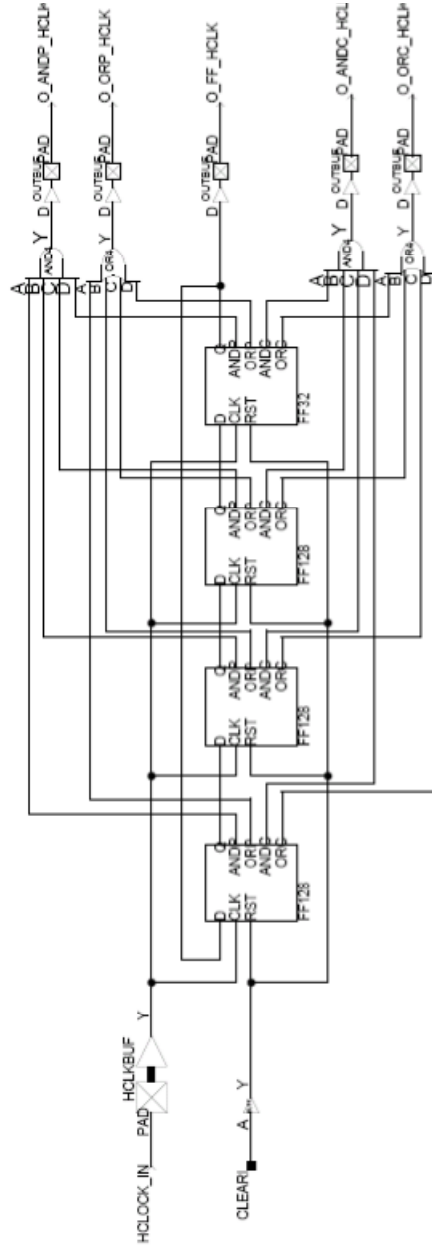


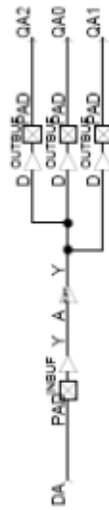
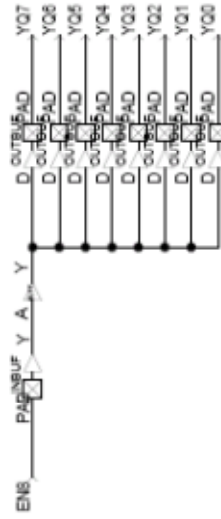
Figure A2 Power Supply, Ground and Special Pins Bias During Irradiation

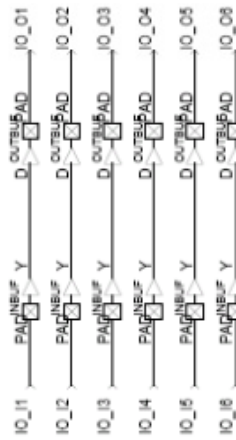
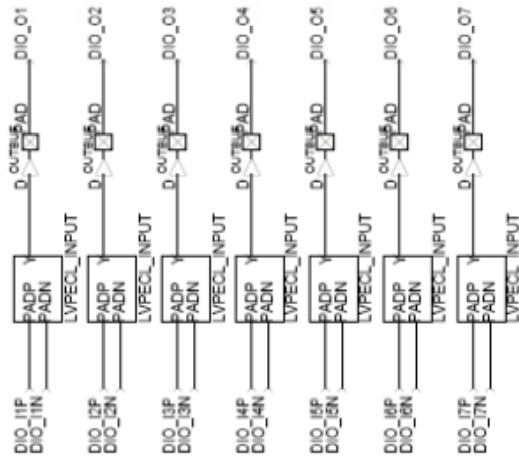
Appendix B DUT Design Schematics and Verilog Files

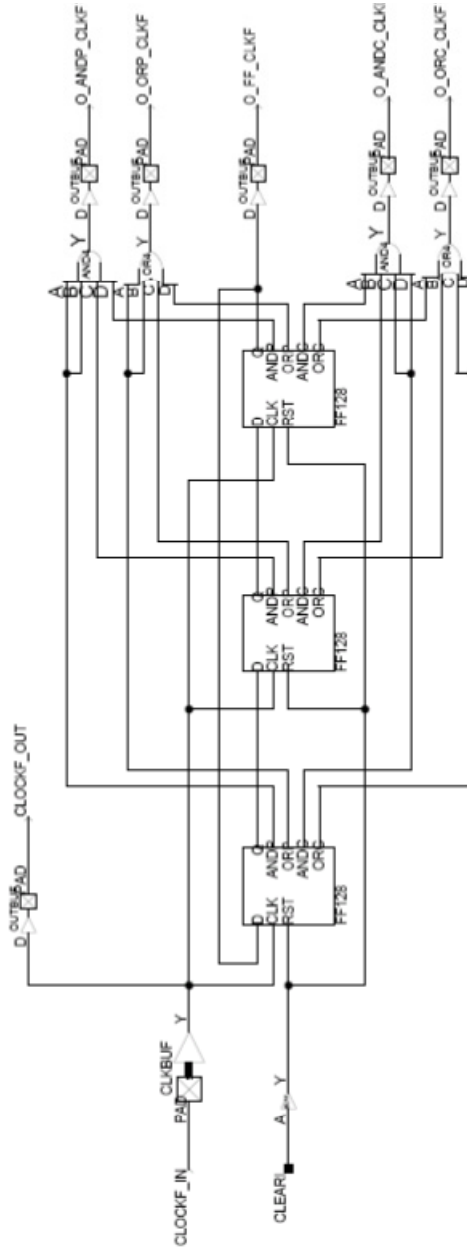


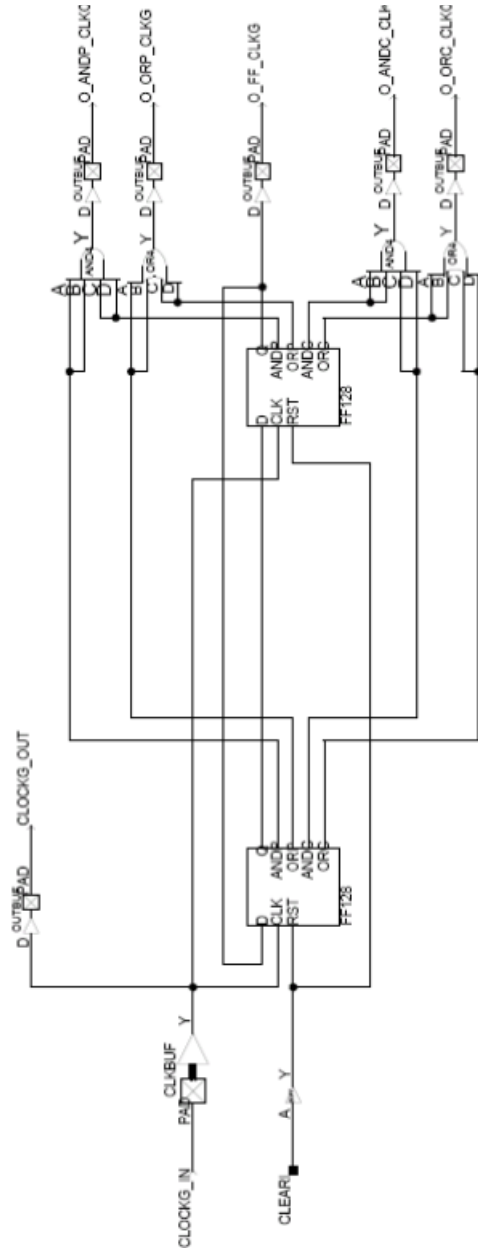


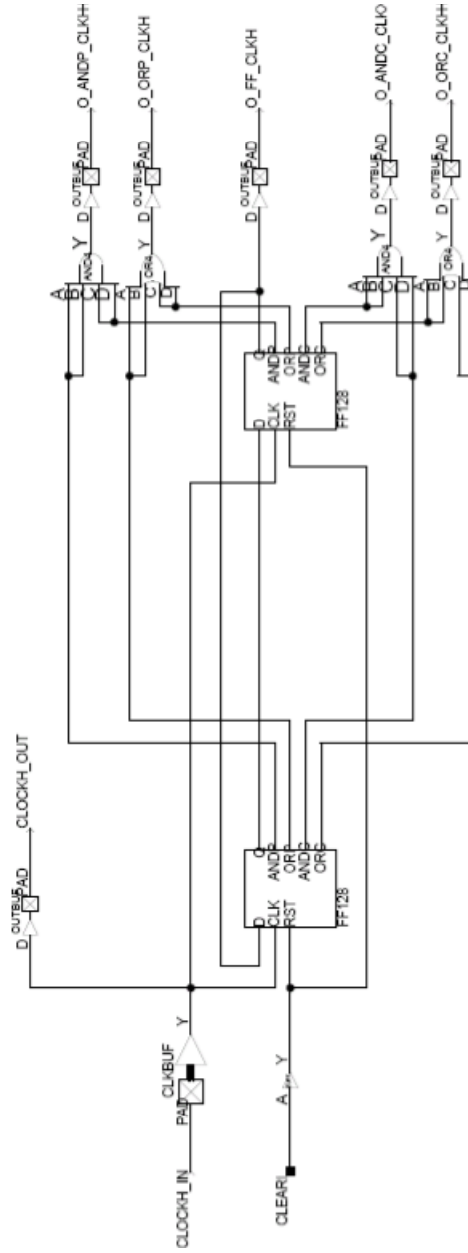












```
// BUFF2p3k.v
`timescale 1 ns/100 ps

module BUFF2p3k (In, Out);

input In;

output Out;

wire x1/*synthesis syn_keep=1 alspreserve=1*/;
wire x2/*synthesis syn_keep=1 alspreserve=1*/;
wire x3/*synthesis syn_keep=1 alspreserve=1*/;
wire x4/*synthesis syn_keep=1 alspreserve=1*/;
wire x5/*synthesis syn_keep=1 alspreserve=1*/;
wire x6/*synthesis syn_keep=1 alspreserve=1*/;
wire x7/*synthesis syn_keep=1 alspreserve=1*/;

BUFF1k buff1k_1 (.In(In), .Out(x1));
BUFF1k buff1k_2 (.In(x1), .Out(x2));
BUFF50 buff3 (.In(x2), .Out(x3));
BUFF50 buff4 (.In(x3), .Out(x4));
BUFF50 buff5 (.In(x4), .Out(x5));
BUFF50 buff6 (.In(x5), .Out(x6));
BUFF50 buff7 (.In(x6), .Out(x7));
BUFF50 buff8 (.In(x7), .Out(Out));

endmodule

// BUFF1k
`timescale 1 ns/100 ps

module BUFF1k (In, Out);

input In;

output Out;

wire x1/*synthesis syn_keep=1 alspreserve=1*/;
wire x2/*synthesis syn_keep=1 alspreserve=1*/;
wire x3/*synthesis syn_keep=1 alspreserve=1*/;
wire x4/*synthesis syn_keep=1 alspreserve=1*/;
wire x5/*synthesis syn_keep=1 alspreserve=1*/;
wire x6/*synthesis syn_keep=1 alspreserve=1*/;
wire x7/*synthesis syn_keep=1 alspreserve=1*/;
wire x8/*synthesis syn_keep=1 alspreserve=1*/;
wire x9/*synthesis syn_keep=1 alspreserve=1*/;
wire x10/*synthesis syn_keep=1 alspreserve=1*/;
wire x11/*synthesis syn_keep=1 alspreserve=1*/;
wire x12/*synthesis syn_keep=1 alspreserve=1*/;
wire x13/*synthesis syn_keep=1 alspreserve=1*/;
wire x14/*synthesis syn_keep=1 alspreserve=1*/;
wire x15/*synthesis syn_keep=1 alspreserve=1*/;
wire x16/*synthesis syn_keep=1 alspreserve=1*/;
wire x17/*synthesis syn_keep=1 alspreserve=1*/;
wire x18/*synthesis syn_keep=1 alspreserve=1*/;
wire x19/*synthesis syn_keep=1 alspreserve=1*/;
```

```
BUFF50 buff1 (.In(In), .Out(x1));
BUFF50 buff2 (.In(x1), .Out(x2));
BUFF50 buff3 (.In(x2), .Out(x3));
BUFF50 buff4 (.In(x3), .Out(x4));
BUFF50 buff5 (.In(x4), .Out(x5));
BUFF50 buff6 (.In(x5), .Out(x6));
BUFF50 buff7 (.In(x6), .Out(x7));
BUFF50 buff8 (.In(x7), .Out(x8));
BUFF50 buff9 (.In(x8), .Out(x9));
BUFF50 buff10 (.In(x9), .Out(x10));
```

```
BUFF50 buff11 (.In(x10), .Out(x11));
BUFF50 buff12 (.In(x11), .Out(x12));
BUFF50 buff13 (.In(x12), .Out(x13));
BUFF50 buff14 (.In(x13), .Out(x14));
BUFF50 buff15 (.In(x14), .Out(x15));
BUFF50 buff16 (.In(x15), .Out(x16));
BUFF50 buff17 (.In(x16), .Out(x17));
BUFF50 buff18 (.In(x17), .Out(x18));
BUFF50 buff19 (.In(x18), .Out(x19));
BUFF50 buff20 (.In(x19), .Out(Out));
```

```
endmodule
```

```
// BUFF50
```

```
`timescale 1 ns/100 ps
```

```
module BUFF50 (In, Out);
```

```
input In;
```

```
output Out;
```

```
wire x1 /*synthesis syn_keep=1 alspreserve=1*/;
wire x2 /*synthesis syn_keep=1 alspreserve=1*/;
wire x3 /*synthesis syn_keep=1 alspreserve=1*/;
wire x4 /*synthesis syn_keep=1 alspreserve=1*/;
wire x5 /*synthesis syn_keep=1 alspreserve=1*/;
wire x6 /*synthesis syn_keep=1 alspreserve=1*/;
wire x7 /*synthesis syn_keep=1 alspreserve=1*/;
wire x8 /*synthesis syn_keep=1 alspreserve=1*/;
wire x9 /*synthesis syn_keep=1 alspreserve=1*/;
wire x10 /*synthesis syn_keep=1 alspreserve=1*/;
wire x11 /*synthesis syn_keep=1 alspreserve=1*/;
wire x12 /*synthesis syn_keep=1 alspreserve=1*/;
wire x13 /*synthesis syn_keep=1 alspreserve=1*/;
wire x14 /*synthesis syn_keep=1 alspreserve=1*/;
wire x15 /*synthesis syn_keep=1 alspreserve=1*/;
wire x16 /*synthesis syn_keep=1 alspreserve=1*/;
wire x17 /*synthesis syn_keep=1 alspreserve=1*/;
wire x18 /*synthesis syn_keep=1 alspreserve=1*/;
wire x19 /*synthesis syn_keep=1 alspreserve=1*/;
wire x20 /*synthesis syn_keep=1 alspreserve=1*/;
wire x21 /*synthesis syn_keep=1 alspreserve=1*/;
wire x22 /*synthesis syn_keep=1 alspreserve=1*/;
```

```
wire x23/*synthesis syn_keep=1 alspreserve=1*/;  
wire x24/*synthesis syn_keep=1 alspreserve=1*/;  
wire x25/*synthesis syn_keep=1 alspreserve=1*/;  
wire x26/*synthesis syn_keep=1 alspreserve=1*/;  
wire x27/*synthesis syn_keep=1 alspreserve=1*/;  
wire x28/*synthesis syn_keep=1 alspreserve=1*/;  
wire x29/*synthesis syn_keep=1 alspreserve=1*/;  
wire x30/*synthesis syn_keep=1 alspreserve=1*/;  
wire x31/*synthesis syn_keep=1 alspreserve=1*/;  
wire x32/*synthesis syn_keep=1 alspreserve=1*/;  
wire x33/*synthesis syn_keep=1 alspreserve=1*/;  
wire x34/*synthesis syn_keep=1 alspreserve=1*/;  
wire x35/*synthesis syn_keep=1 alspreserve=1*/;  
wire x36/*synthesis syn_keep=1 alspreserve=1*/;  
wire x37/*synthesis syn_keep=1 alspreserve=1*/;  
wire x38/*synthesis syn_keep=1 alspreserve=1*/;  
wire x39/*synthesis syn_keep=1 alspreserve=1*/;  
wire x40/*synthesis syn_keep=1 alspreserve=1*/;  
wire x41/*synthesis syn_keep=1 alspreserve=1*/;  
wire x42/*synthesis syn_keep=1 alspreserve=1*/;  
wire x43/*synthesis syn_keep=1 alspreserve=1*/;  
wire x44/*synthesis syn_keep=1 alspreserve=1*/;  
wire x45/*synthesis syn_keep=1 alspreserve=1*/;  
wire x46/*synthesis syn_keep=1 alspreserve=1*/;  
wire x47/*synthesis syn_keep=1 alspreserve=1*/;  
wire x48/*synthesis syn_keep=1 alspreserve=1*/;  
wire x49/*synthesis syn_keep=1 alspreserve=1*/;
```

```
BUFF buff1 (.A(In), .Y(x1));  
BUFF buff2 (.A(x1), .Y(x2));  
BUFF buff3 (.A(x2), .Y(x3));  
BUFF buff4 (.A(x3), .Y(x4));  
BUFF buff5 (.A(x4), .Y(x5));  
BUFF buff6 (.A(x5), .Y(x6));  
BUFF buff7 (.A(x6), .Y(x7));  
BUFF buff8 (.A(x7), .Y(x8));  
BUFF buff9 (.A(x8), .Y(x9));  
BUFF buff10 (.A(x9), .Y(x10));
```

```
BUFF buff11 (.A(x10), .Y(x11));  
BUFF buff12 (.A(x11), .Y(x12));  
BUFF buff13 (.A(x12), .Y(x13));  
BUFF buff14 (.A(x13), .Y(x14));  
BUFF buff15 (.A(x14), .Y(x15));  
BUFF buff16 (.A(x15), .Y(x16));  
BUFF buff17 (.A(x16), .Y(x17));  
BUFF buff18 (.A(x17), .Y(x18));  
BUFF buff19 (.A(x18), .Y(x19));  
BUFF buff20 (.A(x19), .Y(x20));
```

```
BUFF buff21 (.A(x20), .Y(x21));  
BUFF buff22 (.A(x21), .Y(x22));  
BUFF buff23 (.A(x22), .Y(x23));  
BUFF buff24 (.A(x23), .Y(x24));  
BUFF buff25 (.A(x24), .Y(x25));  
BUFF buff26 (.A(x25), .Y(x26));
```

```
BUFF buff27 (.A(x26), .Y(x27));
BUFF buff28 (.A(x27), .Y(x28));
BUFF buff29 (.A(x28), .Y(x29));
BUFF buff30 (.A(x29), .Y(x30));
```

```
BUFF buff31 (.A(x30), .Y(x31));
BUFF buff32 (.A(x31), .Y(x32));
BUFF buff33 (.A(x32), .Y(x33));
BUFF buff34 (.A(x33), .Y(x34));
BUFF buff35 (.A(x34), .Y(x35));
BUFF buff36 (.A(x35), .Y(x36));
BUFF buff37 (.A(x36), .Y(x37));
BUFF buff38 (.A(x37), .Y(x38));
BUFF buff39 (.A(x38), .Y(x39));
BUFF buff40 (.A(x39), .Y(x40));
```

```
BUFF buff41 (.A(x40), .Y(x41));
BUFF buff42 (.A(x41), .Y(x42));
BUFF buff43 (.A(x42), .Y(x43));
BUFF buff44 (.A(x43), .Y(x44));
BUFF buff45 (.A(x44), .Y(x45));
BUFF buff46 (.A(x45), .Y(x46));
BUFF buff47 (.A(x46), .Y(x47));
BUFF buff48 (.A(x47), .Y(x48));
BUFF buff49 (.A(x48), .Y(x49));
BUFF buff50 (.A(x49), .Y(Out));
```

```
endmodule
```

```
// FF128
```

```
`timescale 1 ns/100 ps
```

```
module FF128 (D, Q, CLK, RST, ANDP, ORP, ANDC, ORC);
```

```
input D, CLK, RST;
```

```
output Q, ANDP, ORP, ANDC, ORC;
```

```
wire x1, x2, x3, Q;
```

```
wire andp_a, andp_b, andp_c, andp_d, orp_a, orp_b, orp_c, orp_d;
```

```
wire andc_a, andc_b, andc_c, andc_d, orc_a, orc_b, orc_c, orc_d;
```

```
FF32 dff_a (.D(D), .Q(x1), .CLK(CLK), .RST(RST), .ANDP(andp_a), .ORP(orp_a),
.ANDC(andc_a), .ORC(orc_a));
```

```
FF32 dff_b (.D(x1), .Q(x2), .CLK(CLK), .RST(RST), .ANDP(andp_b), .ORP(orp_b),
.ANDC(andc_b), .ORC(orc_b));
```

```
FF32 dff_c (.D(x2), .Q(x3), .CLK(CLK), .RST(RST), .ANDP(andp_c), .ORP(orp_c),
.ANDC(andc_c), .ORC(orc_c));
```

```
FF32 dff_d (.D(x3), .Q(Q), .CLK(CLK), .RST(RST), .ANDP(andp_d), .ORP(orp_d),
.ANDC(andc_d), .ORC(orc_d));
```

```
AND4 and4p (.A(andp_a), .B(andp_b), .C(andp_c), .D(andp_d), .Y(ANDP));
```

```
OR4 or4p (.A(orp_a), .B(orp_b), .C(orp_c), .D(orp_d), .Y(ORP));
```

```
AND4 and4c (.A(andc_a), .B(andc_b), .C(andc_c), .D(andc_d), .Y(ANDC));
```



```
OR4 or4c (.A(orc_a), .B(orc_b), .C(orc_c), .D(orc_d), .Y(ORC));

endmodule

// FF32
`timescale 1 ns/100 ps
module FF32 (D, Q, CLK, RST, ANDP, ORP, ANDC, ORC);

input D, CLK, RST;
output Q, ANDP, ORP, ANDC, ORC;

wire x1, x2, x3, Q;
wire andp_a, andp_b, andp_c, andp_d, orp_a, orp_b, orp_c, orp_d;
wire andc_a, andc_b, andc_c, andc_d, orc_a, orc_b, orc_c, orc_d;

FF8 dff_a (.D(D), .Q(x1), .CLK(CLK), .RST(RST), .ANDP(andp_a), .ORP(orp_a),
.ANDC(andc_a), .ORC(orc_a));

FF8 dff_b (.D(x1), .Q(x2), .CLK(CLK), .RST(RST), .ANDP(andp_b), .ORP(orp_b),
.ANDC(andc_b), .ORC(orc_b));

FF8 dff_c (.D(x2), .Q(x3), .CLK(CLK), .RST(RST), .ANDP(andp_c), .ORP(orp_c),
.ANDC(andc_c), .ORC(orc_c));

FF8 dff_d (.D(x3), .Q(Q), .CLK(CLK), .RST(RST), .ANDP(andp_d), .ORP(orp_d),
.ANDC(andc_d), .ORC(orc_d));

AND4 and4p (.A(andp_a), .B(andp_b), .C(andp_c), .D(andp_d), .Y(ANDP));
OR4 or4p (.A(orp_a), .B(orp_b), .C(orp_c), .D(orp_d), .Y(ORP));

AND4 and4c (.A(andc_a), .B(andc_b), .C(andc_c), .D(andc_d), .Y(ANDC));
OR4 or4c (.A(orc_a), .B(orc_b), .C(orc_c), .D(orc_d), .Y(ORC));

endmodule

// FF8
`timescale 1 ns/100 ps

module FF8 (D, Q, CLK, RST, ANDP, ORP, ANDC, ORC);

input D, CLK, RST;
output Q, ANDP, ORP, ANDC, ORC;

wire x1, x2, x3, x4, x5, x6, x7;

DFC1B dff1 (.D(D), .Q(x1), .CLK(CLK), .CLR(RST));
DFP1B dff2 (.D(x1), .Q(x2), .CLK(CLK), .PRE(RST));
DFC1B dff3 (.D(x2), .Q(x3), .CLK(CLK), .CLR(RST));
DFP1B dff4 (.D(x3), .Q(x4), .CLK(CLK), .PRE(RST));
DFC1B dff5 (.D(x4), .Q(x5), .CLK(CLK), .CLR(RST));
DFP1B dff6 (.D(x5), .Q(x6), .CLK(CLK), .PRE(RST));
DFC1B dff7 (.D(x6), .Q(x7), .CLK(CLK), .CLR(RST));
DFP1B dff8 (.D(x7), .Q(Q), .CLK(CLK), .PRE(RST));

AND4 and4p (.A(x2), .B(x4), .C(x6), .D(Q), .Y(ANDP));
OR4 or4p (.A(x2), .B(x4), .C(x6), .D(Q), .Y(ORP));
```

```
AND4 and4c (.A(x1), .B(x3), .C(x5), .D(x7), .Y(ANDC));
OR4 or4c (.A(x1), .B(x3), .C(x5), .D(x7), .Y(ORC));

endmodule

// Top_RAM_Module.v
`timescale 1 ns/100 ps

module Top_RAM_Module(Psel0, Psel1, RC_en, RC_clr, RC_clk, Write, Read, Wclk, Rclk,
    Q_RAM);
input Psel0, Psel1, RC_en, RC_clr, RC_clk, Write, Read, Wclk, Rclk;
output [5:0] Q_RAM;

wire Gnd, Vcc;
wire mx0, mx1;
wire [12:0] rc;
wire [3:0] dec;
wire y_0w, y_0r, y_1w, y_1r, y_2w, y_2r, y_3w, y_3r;
// y_4w, y_4r, y_5w, y_5r, y_6w, y_6r, y_7w, y_7r;
wire [5:0] DIN;
wire [5:0] Q_b0;
wire [5:0] Q_b1;
wire [5:0] Q_b2;
wire [5:0] Q_b3;
//wire [5:0] Q_b4;
//wire [5:0] Q_b5;
//wire [5:0] Q_b6;
//wire [5:0] Q_b7;

GND gnd_0(.Y(Gnd));
VCC vcc_0(.Y(Vcc));

mux_2x1 mux_0(.Data0_port(Gnd), .Data1_port(Vcc), .Sel0(Psel0), .Result(mx0));
mux_2x1 mux_1(.Data0_port(Gnd), .Data1_port(Vcc), .Sel0(Psel1), .Result(mx1));

counter_13 counter_0(.Enable(RC_en), .Aclr(RC_clr), .Clock(RC_clk), .Q(rc));

decoder_2to4 decoder_0(.Data0(rc[11]), .Data1(rc[12]), .Eq(dec));

NAND2 nand_0w(.A(dec[0]), .B(Write), .Y(y_0w));
NAND2 nand_0r(.A(dec[0]), .B(Read), .Y(y_0r));

ram_2048x6 ram_blk0(.Data(DIN), .Q(Q_b0), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_0w), .RE(y_0r), .WClock(Wclk), .RClock(Rclk));

assign DIN[0]=mx0, DIN[1]=mx1, DIN[2]=mx0, DIN[3]=mx1, DIN[4]=mx0, DIN[5]=mx1;

NAND2 nand_1w(.A(dec[1]), .B(Write), .Y(y_1w));
NAND2 nand_1r(.A(dec[1]), .B(Read), .Y(y_1r));

ram_2048x6 ram_blk1(.Data(DIN), .Q(Q_b1), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_1w), .RE(y_1r), .WClock(Wclk), .RClock(Rclk));

NAND2 nand_2w(.A(dec[2]), .B(Write), .Y(y_2w));
NAND2 nand_2r(.A(dec[2]), .B(Read), .Y(y_2r));
```

```
ram_2048x6 ram_blk2(.Data(DIN),
    .Q(Q_b2), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_2w), .RE(y_2r), .WClock(Wclk), .RClock(Rclk));

NAND2 nand_3w(.A(dec[3]), .B(Write), .Y(y_3w));
NAND2 nand_3r(.A(dec[3]), .B(Read), .Y(y_3r));

ram_2048x6 ram_blk3(.Data(DIN),
    .Q(Q_b3), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_3w), .RE(y_3r), .WClock(Wclk), .RClock(Rclk));

/* NAND2 nand_4w(.A(dec[4]), .B(Write), .Y(y_4w));
NAND2 nand_4r(.A(dec[4]), .B(Read), .Y(y_4r));

ram_2048x3 ram_blk4(.Data(DIN),
    .Q(Q_b4), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_4w), .RE(y_4r), .WClock(Wclk), .RClock(Rclk));

NAND2 nand_5w(.A(dec[5]), .B(Write), .Y(y_5w));
NAND2 nand_5r(.A(dec[5]), .B(Read), .Y(y_5r));

ram_2048x3 ram_blk5(.Data(DIN),
    .Q(Q_b5), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_5w), .RE(y_5r), .WClock(Wclk), .RClock(Rclk));

NAND2 nand_6w(.A(dec[6]), .B(Write), .Y(y_6w));
NAND2 nand_6r(.A(dec[6]), .B(Read), .Y(y_6r));

ram_2048x3 ram_blk6(.Data(DIN),
    .Q(Q_b6), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_6w), .RE(y_6r), .WClock(Wclk), .RClock(Rclk));

NAND2 nand_7w(.A(dec[7]), .B(Write), .Y(y_7w));
NAND2 nand_7r(.A(dec[7]), .B(Read), .Y(y_7r));

ram_2048x3 ram_blk7(.Data(DIN),
    .Q(Q_b7), .WAddress(rc[10:0]), .RAddress(rc[10:0]),
    .WE(y_7w), .RE(y_7r), .WClock(Wclk), .RClock(Rclk)); */

mux_6x4 mux_6x4_0(.Data0_port(Q_b0), .Data1_port(Q_b1), .Data2_port(Q_b2),
    .Data3_port(Q_b3), .Sel0(rc[11]),
    .Sel1(rc[12]), .Result(Q_RAM));

endmodule
```

```
`timescale 1 ns/100 ps
// Version: 6.0 SP3 6.0.30.3
```

```
module mux_2x1(Data0_port,Data1_port,Sel0,Result);
input Data0_port, Data1_port, Sel0;
output Result;

    MX2 MX2_Result(.A(Data0_port), .B(Data1_port), .S(Sel0), .Y(
        Result));
```

```
endmodule
```

```
`timescale 1 ns/100 ps
// Version: 6.2 SP2 6.2.52.7
```

```
module counter_13(Enable,Aclr,Clock,Q);
input Enable, Aclr, Clock;
output [12:0] Q;

    wire ClrAux_0_net, ClrAux_7_net, MX2_1_Y, MX2_7_Y, MX2_4_Y,
        CM8_0_Y, MX2_10_Y, MX2_9_Y, MX2_3_Y, MX2_5_Y, MX2_6_Y,
        MX2_0_Y, MX2_8_Y, MX2_2_Y, MX2_11_Y, VCC, GND;

    VCC VCC_1_net(.Y(VCC));
    GND GND_1_net(.Y(GND));
    DFC1D DFC1D_Q_7_inst(.D(MX2_1_Y), .CLK(Q[6]), .CLR(
        ClrAux_7_net), .Q(Q[7]));
    DFC1D DFC1D_Q_1_inst(.D(MX2_7_Y), .CLK(Q[0]), .CLR(
        ClrAux_0_net), .Q(Q[1]));
    BUFF BUFF_ClrAux_0_inst(.A(Aclr), .Y(ClrAux_0_net));
    MX2 MX2_9(.A(VCC), .B(GND), .S(Q[5]), .Y(MX2_9_Y));
    DFC1D DFC1D_Q_2_inst(.D(MX2_6_Y), .CLK(Q[1]), .CLR(
        ClrAux_0_net), .Q(Q[2]));
    MX2 MX2_0(.A(VCC), .B(GND), .S(Q[8]), .Y(MX2_0_Y));
    DFC1D DFC1D_Q_12_inst(.D(MX2_4_Y), .CLK(Q[11]), .CLR(
        ClrAux_7_net), .Q(Q[12]));
    DFC1D DFC1D_Q_3_inst(.D(MX2_11_Y), .CLK(Q[2]), .CLR(
        ClrAux_0_net), .Q(Q[3]));
    DFC1D DFC1D_Q_4_inst(.D(MX2_5_Y), .CLK(Q[3]), .CLR(
        ClrAux_0_net), .Q(Q[4]));
    CM8 CM8_0(.D0(GND), .D1(VCC), .D2(VCC), .D3(GND), .S00(Q[0]),
        .S01(VCC), .S10(Enable), .S11(GND), .Y(CM8_0_Y));
    MX2 MX2_11(.A(VCC), .B(GND), .S(Q[3]), .Y(MX2_11_Y));
    DFC1B DFC1B_Q_0_inst(.D(CM8_0_Y), .CLK(Clock), .CLR(
        ClrAux_0_net), .Q(Q[0]));
    MX2 MX2_6(.A(VCC), .B(GND), .S(Q[2]), .Y(MX2_6_Y));
    MX2 MX2_3(.A(VCC), .B(GND), .S(Q[10]), .Y(MX2_3_Y));
    DFC1D DFC1D_Q_11_inst(.D(MX2_10_Y), .CLK(Q[10]), .CLR(
        ClrAux_7_net), .Q(Q[11]));
    MX2 MX2_10(.A(VCC), .B(GND), .S(Q[11]), .Y(MX2_10_Y));
    BUFF BUFF_ClrAux_7_inst(.A(Aclr), .Y(ClrAux_7_net));
    MX2 MX2_4(.A(VCC), .B(GND), .S(Q[12]), .Y(MX2_4_Y));
    DFC1D DFC1D_Q_5_inst(.D(MX2_9_Y), .CLK(Q[4]), .CLR(
```

```

    ClrAux_0_net), .Q(Q[5]));
DFC1D DFC1D_Q_9_inst(.D(MX2_8_Y), .CLK(Q[8]), .CLR(
    ClrAux_7_net), .Q(Q[9]));
MX2 MX2_5(.A(VCC), .B(GND), .S(Q[4]), .Y(MX2_5_Y));
MX2 MX2_8(.A(VCC), .B(GND), .S(Q[9]), .Y(MX2_8_Y));
DFC1D DFC1D_Q_8_inst(.D(MX2_0_Y), .CLK(Q[7]), .CLR(
    ClrAux_7_net), .Q(Q[8]));
MX2 MX2_2(.A(VCC), .B(GND), .S(Q[6]), .Y(MX2_2_Y));
MX2 MX2_7(.A(VCC), .B(GND), .S(Q[1]), .Y(MX2_7_Y));
MX2 MX2_1(.A(VCC), .B(GND), .S(Q[7]), .Y(MX2_1_Y));
DFC1D DFC1D_Q_6_inst(.D(MX2_2_Y), .CLK(Q[5]), .CLR(
    ClrAux_0_net), .Q(Q[6]));
DFC1D DFC1D_Q_10_inst(.D(MX2_3_Y), .CLK(Q[9]), .CLR(
    ClrAux_7_net), .Q(Q[10]));

endmodule

`timescale 1 ns/100 ps
// Version: 6.2 SP2 6.2.52.7

module decoder_2to4(Data0,Data1,Eq);
input Data0, Data1;
output [3:0] Eq;

    AND2A AND2A_Eq_1_inst(.A(Data1), .B(Data0), .Y(Eq[1]));
    AND2 AND2_Eq_3_inst(.A(Data0), .B(Data1), .Y(Eq[3]));
    AND2A AND2A_Eq_2_inst(.A(Data0), .B(Data1), .Y(Eq[2]));
    AND2B AND2B_Eq_0_inst(.A(Data0), .B(Data1), .Y(Eq[0]));

endmodule

`timescale 1 ns/100 ps
// Version: 6.2 SP2 6.2.52.7

module ram_2048x6(Data,Q,WAddress,RAddress,WE,RE,WClock,RClock);
input [5:0] Data;
output [5:0] Q;
input [10:0] WAddress, RAddress;
input WE, RE, WClock, RClock;

    wire WEP, REP, VCC, GND;

    VCC VCC_1_net(.Y(VCC));
    GND GND_1_net(.Y(GND));
    RAM64K36P ram_2048x6_R0C2(.WCLK(WClock), .RCLK(RClock),
        .DEPTH0(GND), .DEPTH1(GND), .DEPTH2(GND), .DEPTH3(GND),
        .WEN(WEP), .WW0(VCC), .WW1(GND), .WW2(GND), .WRAD0(
        WAddress[0]), .WRAD1(WAddress[1]), .WRAD2(WAddress[2]),
        .WRAD3(WAddress[3]), .WRAD4(WAddress[4]), .WRAD5(
        WAddress[5]), .WRAD6(WAddress[6]), .WRAD7(WAddress[7]),
        .WRAD8(WAddress[8]), .WRAD9(WAddress[9]), .WRAD10(
        WAddress[10]), .WRAD11(GND), .WRAD12(GND), .WRAD13(GND),
        .WRAD14(GND), .WRAD15(GND), .WD0(Data[4]), .WD1(Data[5]),

```

```
.WD2(GND), .WD3(GND), .WD4(GND), .WD5(GND), .WD6(GND),
.WD7(GND), .WD8(GND), .WD9(GND), .WD10(GND), .WD11(GND),
.WD12(GND), .WD13(GND), .WD14(GND), .WD15(GND), .WD16(GND)
, .WD17(GND), .WD18(GND), .WD19(GND), .WD20(GND), .WD21(
GND), .WD22(GND), .WD23(GND), .WD24(GND), .WD25(GND),
.WD26(GND), .WD27(GND), .WD28(GND), .WD29(GND), .WD30(GND)
, .WD31(GND), .WD32(GND), .WD33(GND), .WD34(GND), .WD35(
GND), .REN(REP), .RW0(VCC), .RW1(GND), .RW2(GND), .RDAD0(
RAddress[0]), .RDAD1(RAddress[1]), .RDAD2(RAddress[2]),
.RDAD3(RAddress[3]), .RDAD4(RAddress[4]), .RDAD5(
RAddress[5]), .RDAD6(RAddress[6]), .RDAD7(RAddress[7]),
.RDAD8(RAddress[8]), .RDAD9(RAddress[9]), .RDAD10(
RAddress[10]), .RDAD11(GND), .RDAD12(GND), .RDAD13(GND),
.RDAD14(GND), .RDAD15(GND), .RD0(Q[4]), .RD1(Q[5]), .RD2(
), .RD3(), .RD4(), .RD5(), .RD6(), .RD7(), .RD8(), .RD9(),
.RD10(), .RD11(), .RD12(), .RD13(), .RD14(), .RD15(),
.RD16(), .RD17(), .RD18(), .RD19(), .RD20(), .RD21(),
.RD22(), .RD23(), .RD24(), .RD25(), .RD26(), .RD27(),
.RD28(), .RD29(), .RD30(), .RD31(), .RD32(), .RD33(),
.RD34(), .RD35());
INV REBUBBLE(.A(RE), .Y(REP));
INV WEBUBBLE(.A(WE), .Y(WEP));
RAM64K36P ram_2048x6_R0C1(.WCLK(WClock), .RCLK(RClock),
.DEPTH0(GND), .DEPTH1(GND), .DEPTH2(GND), .DEPTH3(GND),
.WEN(WEP), .WW0(VCC), .WW1(GND), .WW2(GND), .WRAD0(
WAddress[0]), .WRAD1(WAddress[1]), .WRAD2(WAddress[2]),
.WRAD3(WAddress[3]), .WRAD4(WAddress[4]), .WRAD5(
WAddress[5]), .WRAD6(WAddress[6]), .WRAD7(WAddress[7]),
.WRAD8(WAddress[8]), .WRAD9(WAddress[9]), .WRAD10(
WAddress[10]), .WRAD11(GND), .WRAD12(GND), .WRAD13(GND),
.WRAD14(GND), .WRAD15(GND), .WD0(Data[2]), .WD1(Data[3]),
.WD2(GND), .WD3(GND), .WD4(GND), .WD5(GND), .WD6(GND),
.WD7(GND), .WD8(GND), .WD9(GND), .WD10(GND), .WD11(GND),
.WD12(GND), .WD13(GND), .WD14(GND), .WD15(GND), .WD16(GND)
, .WD17(GND), .WD18(GND), .WD19(GND), .WD20(GND), .WD21(
GND), .WD22(GND), .WD23(GND), .WD24(GND), .WD25(GND),
.WD26(GND), .WD27(GND), .WD28(GND), .WD29(GND), .WD30(GND)
, .WD31(GND), .WD32(GND), .WD33(GND), .WD34(GND), .WD35(
GND), .REN(REP), .RW0(VCC), .RW1(GND), .RW2(GND), .RDAD0(
RAddress[0]), .RDAD1(RAddress[1]), .RDAD2(RAddress[2]),
.RDAD3(RAddress[3]), .RDAD4(RAddress[4]), .RDAD5(
RAddress[5]), .RDAD6(RAddress[6]), .RDAD7(RAddress[7]),
.RDAD8(RAddress[8]), .RDAD9(RAddress[9]), .RDAD10(
RAddress[10]), .RDAD11(GND), .RDAD12(GND), .RDAD13(GND),
.RDAD14(GND), .RDAD15(GND), .RD0(Q[2]), .RD1(Q[3]), .RD2(
), .RD3(), .RD4(), .RD5(), .RD6(), .RD7(), .RD8(), .RD9(),
.RD10(), .RD11(), .RD12(), .RD13(), .RD14(), .RD15(),
.RD16(), .RD17(), .RD18(), .RD19(), .RD20(), .RD21(),
.RD22(), .RD23(), .RD24(), .RD25(), .RD26(), .RD27(),
.RD28(), .RD29(), .RD30(), .RD31(), .RD32(), .RD33(),
.RD34(), .RD35());
RAM64K36P ram_2048x6_R0C0(.WCLK(WClock), .RCLK(RClock),
.DEPTH0(GND), .DEPTH1(GND), .DEPTH2(GND), .DEPTH3(GND),
.WEN(WEP), .WW0(VCC), .WW1(GND), .WW2(GND), .WRAD0(
WAddress[0]), .WRAD1(WAddress[1]), .WRAD2(WAddress[2]),
.WRAD3(WAddress[3]), .WRAD4(WAddress[4]), .WRAD5(
```

```

WAddress[5]), .WRAD6(WAddress[6]), .WRAD7(WAddress[7]),
.WRAD8(WAddress[8]), .WRAD9(WAddress[9]), .WRAD10(
WAddress[10]), .WRAD11(GND), .WRAD12(GND), .WRAD13(GND),
.WRAD14(GND), .WRAD15(GND), .WD0(Data[0]), .WD1(Data[1]),
.WD2(GND), .WD3(GND), .WD4(GND), .WD5(GND), .WD6(GND),
.WD7(GND), .WD8(GND), .WD9(GND), .WD10(GND), .WD11(GND),
.WD12(GND), .WD13(GND), .WD14(GND), .WD15(GND), .WD16(GND)
, .WD17(GND), .WD18(GND), .WD19(GND), .WD20(GND), .WD21(
GND), .WD22(GND), .WD23(GND), .WD24(GND), .WD25(GND),
.WD26(GND), .WD27(GND), .WD28(GND), .WD29(GND), .WD30(GND)
, .WD31(GND), .WD32(GND), .WD33(GND), .WD34(GND), .WD35(
GND), .REN(REP), .RW0(VCC), .RW1(GND), .RW2(GND), .RDAD0(
RAddress[0]), .RDAD1(RAddress[1]), .RDAD2(RAddress[2]),
.RDAD3(RAddress[3]), .RDAD4(RAddress[4]), .RDAD5(
RAddress[5]), .RDAD6(RAddress[6]), .RDAD7(RAddress[7]),
.RDAD8(RAddress[8]), .RDAD9(RAddress[9]), .RDAD10(
RAddress[10]), .RDAD11(GND), .RDAD12(GND), .RDAD13(GND),
.RDAD14(GND), .RDAD15(GND), .RD0(Q[0]), .RD1(Q[1]), .RD2()
, .RD3(), .RD4(), .RD5(), .RD6(), .RD7(), .RD8(), .RD9(),
.RD10(), .RD11(), .RD12(), .RD13(), .RD14(), .RD15(),
.RD16(), .RD17(), .RD18(), .RD19(), .RD20(), .RD21(),
.RD22(), .RD23(), .RD24(), .RD25(), .RD26(), .RD27(),
.RD28(), .RD29(), .RD30(), .RD31(), .RD32(), .RD33(),
.RD34(), .RD35());

```

```
endmodule
```

```

`timescale 1 ns/100 ps
// Version: 6.2 SP2 6.2.52.7

```

```

module mux_6x4(Data0_port,Data1_port,Data2_port,Data3_port,Sel0,
Sel1,Result);
input [5:0] Data0_port, Data1_port, Data2_port, Data3_port;
input Sel0, Sel1;
output [5:0] Result;

```

```

MX4 MX4_Result_0_inst(.D0(Data0_port[0]), .D1(Data1_port[0]),
.D2(Data2_port[0]), .D3(Data3_port[0]), .S0(Sel0), .S1(
Sel1), .Y(Result[0]));
MX4 MX4_Result_2_inst(.D0(Data0_port[2]), .D1(Data1_port[2]),
.D2(Data2_port[2]), .D3(Data3_port[2]), .S0(Sel0), .S1(
Sel1), .Y(Result[2]));
MX4 MX4_Result_5_inst(.D0(Data0_port[5]), .D1(Data1_port[5]),
.D2(Data2_port[5]), .D3(Data3_port[5]), .S0(Sel0), .S1(
Sel1), .Y(Result[5]));
MX4 MX4_Result_1_inst(.D0(Data0_port[1]), .D1(Data1_port[1]),
.D2(Data2_port[1]), .D3(Data3_port[1]), .S0(Sel0), .S1(
Sel1), .Y(Result[1]));
MX4 MX4_Result_4_inst(.D0(Data0_port[4]), .D1(Data1_port[4]),
.D2(Data2_port[4]), .D3(Data3_port[4]), .S0(Sel0), .S1(
Sel1), .Y(Result[4]));
MX4 MX4_Result_3_inst(.D0(Data0_port[3]), .D1(Data1_port[3]),
.D2(Data2_port[3]), .D3(Data3_port[3]), .S0(Sel0), .S1(
Sel1), .Y(Result[3]));

```

```
endmodule
```



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